

## 262, 144WORDS×4BITS MULTIPOINT DRAM

## PRELIMINARY

## DESCRIPTION

The TC524259BJ/BZ is a CMOS multiport memory equipped with a 262,144-words by 4-bits dynamic random access memory (RAM) port and a 512-words by 4-bits static serial access memory (SAM) port. The TC524259BJ/BZ supports three types of operations: random access to and from the RAM port, high speed serial access to and from the SAM port and bidirectional transfer of data between any selected row in the RAM port and the SAM port. The RAM port and the SAM port can be accessed independently except when data is being transferred between them internally. In addition to the conventional multiport video RAM operating modes, the TC524259BJ/BZ features the block write and flash write functions on the RAM port and a split register data transfer capability on the SAM port. The TC524259BJ/BZ is fabricated using Toshiba's CMOS silicon gate process as well as advanced circuit designs to provide low power dissipation and wide operating margins.

## FEATURES

| ITEM                                            | TC524259BJ/BZ |       |
|-------------------------------------------------|---------------|-------|
|                                                 | - 80          | - 10  |
| $t_{RAC}$ RAS Access Time (Max.)                | 80ns          | 100ns |
| $t_{CAC}$ CAS Access Time (Max.)                | 25ns          | 25ns  |
| $t_{AAC}$ Column Address Access Time (Max.)     | 45ns          | 50ns  |
| $t_{RC}$ Cycle Time (Min.)                      | 150ns         | 180ns |
| $t_{FC}$ Page Mode Cycle Time (Min.)            | 50ns          | 55ns  |
| $t_{SCA}$ Serial Access Time (Max.)             | 25ns          | 25ns  |
| $t_{SCC}$ Serial Cycle time (Min.)              | 30ns          | 30ns  |
| $I_{CC1}$ RAM Operating Current (SAM: Standby)  | 85mA          | 70mA  |
| $I_{CC2A}$ SAM Operating Current (RAM: Standby) | 50mA          | 50mA  |
| $I_{CC2}$ Standby Current                       | 10mA          | 10mA  |

- Single power supply of  $5V \pm 10\%$  with a built-in  $V_{BB}$  generator
- All inputs and outputs: TTL Compatible

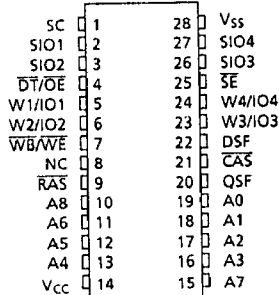
- Organization  
RAM Port : 262,144words×4bits  
SAM Port : 512words×4bits
- RAM Port  
Fast Page Mode, Read-Modify-Write  
CAS before RAS Refresh, Hidden Refresh  
RAS only Refresh, Write per Bit 1&2  
Block Write, Block Write (Mask 1&2)  
512 refresh cycles/8ms
- SAM Port  
High Speed Serial Read/Write Capability  
512 Tap Locations  
Fully Static Register
- RAM-SAM Bidirectional Transfer  
Read/Write/Pseudo Write Transfer  
Real Time Read Transfer  
Split Read Transfer
- Package  
TC524259BJ : SOJ28-P-400  
TC524259BZ : ZIP28-P-400

## PIN NAME

|                 |                             |
|-----------------|-----------------------------|
| A0~A8           | Address inputs              |
| RAS             | Row Address Strobe          |
| CAS             | Column Address Strobe       |
| DT/OE           | Data Transfer/Output Enable |
| WB/WE           | Write per Bit/Write Enable  |
| DSF             | Special Function Control    |
| W1/O1~W4/O4     | Write Mask/Data IN, OUT     |
| SC              | Serial Clock                |
| SE              | Serial Enable               |
| SIO1~SIO4       | Serial Input/Output         |
| QSF             | Special Flag Output         |
| $V_{CC}/V_{SS}$ | Power (5V)/Ground           |
| N. C.           | No Connection               |

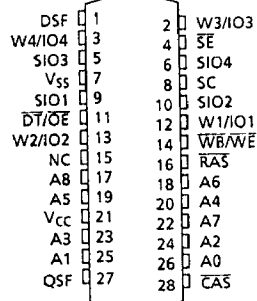
## PIN CONNECTION

TC524259BJ



28Pin 400mil SOJ  
JEDEC Standard

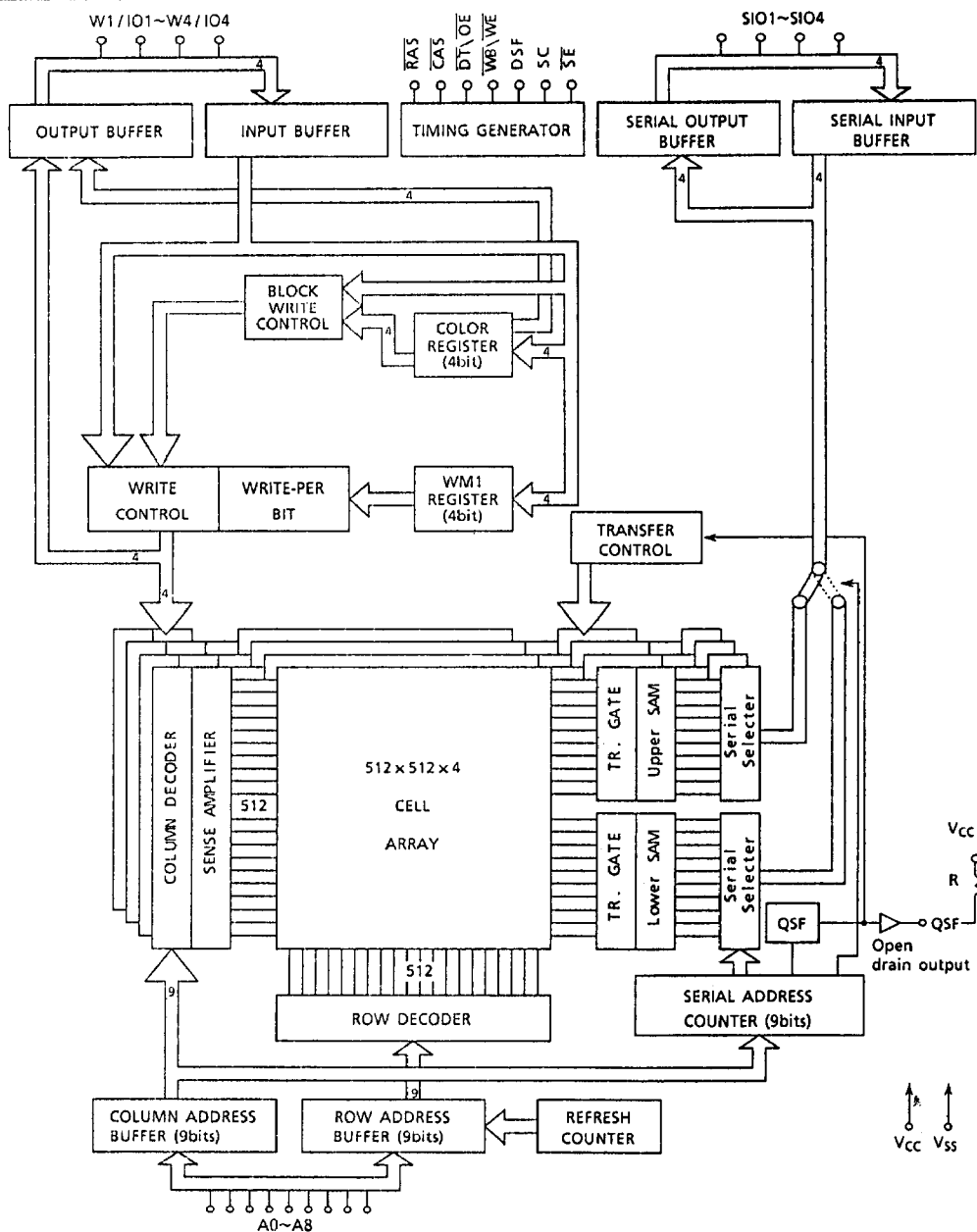
TC524259BZ



28Pin 400mil height ZIP  
JEDEC Standard

**TC524259BJ/BZ-80, TC524259BJ/BZ-10**

### BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

| SYMBOL            | ITEM                         | RATING    | UNIT   | NOTE |
|-------------------|------------------------------|-----------|--------|------|
| $V_{IN}, V_{OUT}$ | Input Output Voltage         | - 1.0~7.0 | V      | 1    |
| $V_{CC}$          | Power Supply Voltage         | - 1.0~7.0 | V      | 1    |
| $T_{OPR}$         | Operating Temperature        | 0~70      | °C     | 1    |
| $T_{STG}$         | Storage Temperature          | - 55~150  | °C     | 1    |
| $T_{SOLDER}$      | Soldering Temperature · Time | 260·10    | °C·sec | 1    |
| $P_D$             | Power Dissipation            | 1         | W      | 1    |
| $I_{OUT}$         | Short Circuit Output Current | 50        | mA     | 1    |

## RECOMMENDED D.C. OPERATING CONDITIONS ( $T_a = 0 \sim 70^\circ\text{C}$ )

| SYMBOL   | PARAMETER            | MIN.  | TYP. | MAX. | UNIT | NOTE |
|----------|----------------------|-------|------|------|------|------|
| $V_{CC}$ | Power Supply Voltage | 4.5   | 5.0  | 5.5  | V    | 2    |
| $V_{IH}$ | Input High Voltage   | 2.4   | —    | 6.5  | V    | 2    |
| $V_{IL}$ | Input Low Voltage    | - 1.0 | —    | 0.8  | V    | 2    |

## CAPACITANCE ( $V_{CC} = 5\text{V}$ , $f = 1\text{MHz}$ , $T_a = 25^\circ\text{C}$ )

| SYMBOL   | PARAMETER                | MIN. | MAX. | UNIT |
|----------|--------------------------|------|------|------|
| $C_i$    | Input Capacitance        | —    | 7    | pF   |
| $C_{IO}$ | Input/Output Capacitance | —    | 9    |      |
| $C_O$    | Output Capacitance (QSF) | —    | 9    |      |

Note : This parameter is periodically sampled and is not 100% tested.

# TC524259BJ/BZ-80, TC524259BJ/BZ-10

## D.C. ELECTRICAL CHARACTERISTICS ( $V_{CC} = 5V \pm 10\%$ , $T_a = 0 \sim 70^\circ C$ )

| ITEM (RAM PORT)                                                                                                                                                  | SAM PORT | SYMBOL     | TC524259BJ/BZ-80 |      | TC524259BJ/BZ-10 |      | UNIT | NOTE |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------------|------------------|------|------------------|------|------|------|
|                                                                                                                                                                  |          |            | MIN.             | MAX. | MIN.             | MAX. |      |      |
| OPERATING CURRENT<br>$\overline{RAS}$ , $\overline{CAS}$ Cycling<br>$t_{RC} = t_{RC} \text{ min.}$                                                               | Standby  | $I_{CC1}$  | -                | 85   | -                | 70   | mA   | 3, 4 |
|                                                                                                                                                                  | Active   | $I_{CC1A}$ | -                | 125  | -                | 110  |      | 3, 4 |
| STANDBY CURRENT<br>( $\overline{RAS}$ , $\overline{CAS} = V_{IH}$ )                                                                                              | Standby  | $I_{CC2}$  | -                | 10   | -                | 10   |      |      |
|                                                                                                                                                                  | Active   | $I_{CC2A}$ | -                | 50   | -                | 50   |      | 3, 4 |
| $\overline{RAS}$ ONLY REFRESH CURRENT<br>$\overline{RAS}$ Cycling, $\overline{CAS} = V_{IH}$<br>$t_{RC} = t_{RC} \text{ min.}$                                   | Standby  | $I_{CC3}$  | -                | 85   | -                | 70   |      | 3, 4 |
|                                                                                                                                                                  | Active   | $I_{CC3A}$ | -                | 125  | -                | 110  |      | 3, 4 |
| PAGE MODE CURRENT<br>$\overline{RAS} = V_{IL}$ , $\overline{CAS}$ Cycling<br>$t_{PC} = t_{PC} \text{ min.}$                                                      | Standby  | $I_{CC4}$  | -                | 75   | -                | 60   |      | 3, 4 |
|                                                                                                                                                                  | Active   | $I_{CC4A}$ | -                | 115  | -                | 100  |      | 3, 4 |
| $\overline{CAS}$ BEFORE $\overline{RAS}$ REFRESH CURRENT<br>$\overline{RAS}$ Cycling, $\overline{CAS}$ Before $\overline{RAS}$<br>$t_{RC} = t_{RC} \text{ min.}$ | Standby  | $I_{CC5}$  | -                | 85   | -                | 70   |      | 3, 4 |
|                                                                                                                                                                  | Active   | $I_{CC5A}$ | -                | 125  | -                | 110  |      | 3, 4 |
| DATA TRANSFER CURRENT<br>$\overline{RAS}$ , $\overline{CAS}$ Cycling<br>$t_{RC} = t_{RC} \text{ min.}$                                                           | Standby  | $I_{CC6}$  | -                | 105  | -                | 90   |      | 3, 4 |
|                                                                                                                                                                  | Active   | $I_{CC6A}$ | -                | 145  | -                | 130  |      | 3, 4 |
| BLOCK WRITE CURRENT<br>$\overline{RAS}$ , $\overline{CAS}$ Cycling<br>$t_{RC} = t_{RC} \text{ min.}$                                                             | Standby  | $I_{CCB}$  | -                | 95   | -                | 80   |      | 3, 4 |
|                                                                                                                                                                  | Active   | $I_{CC8A}$ | -                | 135  | -                | 120  |      | 3, 4 |

| ITEM                                                                                       | SYMBOL         | MIN. | MAX. | UNIT    | NOTE |
|--------------------------------------------------------------------------------------------|----------------|------|------|---------|------|
| INPUT LEAKAGE CURRENT<br>$0V \leq V_{IN} \leq 6.5V$ , All other pins not under test = $0V$ | $I_{IL}$       | -10  | 10   | $\mu A$ |      |
| OUTPUT LEAKAGE CURRENT<br>$0V \leq V_{OUT} \leq 5.5V$ , Output Disable                     | $I_{OL}$       | -10  | 10   | $\mu A$ |      |
| OUTPUT "H" LEVEL VOLTAGE<br>$I_{OUT} = -2mA$                                               | $V_{OH}$       | 2.4  | -    | V       |      |
| OUTPUT "L" LEVEL VOLTAGE<br>$I_{OUT} = 2mA$                                                | $V_{OL}$       | -    | 0.4  | V       |      |
| OUTPUT "L" LEVEL VOLTAGE (QSF)<br>$I_{OUT} = 6mA$                                          | $V_{OL} (QSF)$ | -    | 0.4  | V       |      |

# TC524259BJ/BZ-80, TC524259BJ/BZ-10

ELECTRICAL CHARACTERISTICS AND RECOMMENDED A.C. OPERATING CONDITIONS  
( $V_{CC} = 5V \pm 10\%$ ,  $T_a = 0 \sim 70^\circ C$ ) (Notes : 5, 6, 7)

| SYMBOL     | PARAMETER                                               | TC524259BJ/BZ-80 |        | TC524259BJ/BZ-10 |        | UNIT | NOTE |
|------------|---------------------------------------------------------|------------------|--------|------------------|--------|------|------|
|            |                                                         | MIN.             | MAX.   | MIN.             | MAX.   |      |      |
| $t_{RC}$   | Random Read or Write Cycle Time                         | 150              |        | 180              |        | ns   |      |
| $t_{RMW}$  | Read - Modify - Write Cycle Time                        | 195              |        | 235              |        |      |      |
| $t_{PC}$   | Fast Page Mode Cycle Time                               | 50               |        | 55               |        |      |      |
| $t_{PRMW}$ | Fast Page Mode Read - Modify - Write Cycle Time         | 90               |        | 100              |        |      |      |
| $t_{RAC}$  | Access Time from $\overline{RAS}$                       |                  | 80     |                  | 100    |      | 8,14 |
| $t_{AA}$   | Access Time from Column Address                         |                  | 45     |                  | 50     |      | 8,14 |
| $t_{CAC}$  | Access Time from $\overline{CAS}$                       |                  | 25     |                  | 25     |      | 8,15 |
| $t_{CPA}$  | Access Time from $\overline{CAS}$ Precharge             |                  | 45     |                  | 50     |      | 8,15 |
| $t_{OFF}$  | Output Buffer Turn - Off Delay                          | 0                | 20     | 0                | 20     |      | 10   |
| $t_t$      | Transition Time (Rise and Fall)                         | 3                | 35     | 3                | 35     |      | 7    |
| $t_{RP}$   | $\overline{RAS}$ Precharge Time                         | 60               |        | 70               |        |      |      |
| $t_{RAS}$  | $\overline{RAS}$ Pulse Width                            | 80               | 10000  | 100              | 10000  |      |      |
| $t_{RASP}$ | $\overline{RAS}$ Pulse Width (Fast Page Mode Only)      | 80               | 100000 | 100              | 100000 |      |      |
| $t_{RSH}$  | $\overline{RAS}$ Hold Time                              | 25               |        | 25               |        |      |      |
| $t_{CSH}$  | $\overline{CAS}$ Hold Time                              | 80               |        | 100              |        |      |      |
| $t_{CAS}$  | $\overline{CAS}$ Pulse Width                            | 25               | 10000  | 25               | 10000  |      |      |
| $t_{RCD}$  | $\overline{RAS}$ to $\overline{CAS}$ Delay Time         | 20               | 55     | 20               | 75     |      | 14   |
| $t_{RAD}$  | $\overline{RAS}$ to Column Address Delay Time           | 15               | 35     | 15               | 50     |      | 14   |
| $t_{HAL}$  | Column Address to $\overline{RAS}$ Lead Time            | 45               |        | 50               |        |      |      |
| $t_{CRP}$  | $\overline{CAS}$ to $\overline{RAS}$ Precharge Time     | 10               |        | 10               |        |      |      |
| $t_{CPN}$  | $\overline{CAS}$ Precharge Time                         | 10               |        | 10               |        |      |      |
| $t_{CP}$   | $\overline{CAS}$ Precharge Time (Fast Page Mode)        | 10               |        | 10               |        |      |      |
| $t_{ASR}$  | Row Address Set - Up Time                               | 0                |        | 0                |        |      |      |
| $t_{RAH}$  | Row Address Hold Time                                   | 10               |        | 10               |        |      |      |
| $t_{ASC}$  | Column Address Set - Up Time                            | 0                |        | 0                |        |      |      |
| $t_{CAH}$  | Column Address Hold Time                                | 15               |        | 15               |        |      |      |
| $t_{AR}$   | Column Address Hold Time referenced to $\overline{RAS}$ | 55               |        | 70               |        |      |      |
| $t_{RCS}$  | Read Command Set - Up Time                              | 0                |        | 0                |        |      |      |
| $t_{RCH}$  | Read Command Hold Time                                  | 0                |        | 0                |        |      | 11   |
| $t_{RRH}$  | Read Command Hold Time referenced to $\overline{RAS}$   | 0                |        | 0                |        |      | 11   |
| $t_{WCH}$  | Write Command Hold Time                                 | 15               |        | 15               |        |      |      |
| $t_{WCR}$  | Write Command Hold Time referenced to $\overline{RAS}$  | 55               |        | 70               |        |      |      |
| $t_{WP}$   | Write Command Pulse Width                               | 15               |        | 15               |        |      |      |
| $t_{RWL}$  | Write Command to $\overline{RAS}$ Lead Time             | 20               |        | 25               |        |      |      |
| $t_{CWL}$  | Write Command to $\overline{CAS}$ Lead Time             | 20               |        | 25               |        |      |      |

# TC524259BJ/BZ-80, TC524259BJ/BZ-10

| SYMBOL            | PARAMETER                                                                                 | TC524259BJ / BZ-80 |       | TC524259BJ / BZ-10 |       | UNIT | NOTE |
|-------------------|-------------------------------------------------------------------------------------------|--------------------|-------|--------------------|-------|------|------|
|                   |                                                                                           | MIN.               | MAX.  | MIN.               | MAX.  |      |      |
| t <sub>DS</sub>   | Data Set-Up Time                                                                          | 0                  |       | 0                  |       | ns   | 12   |
| t <sub>DH</sub>   | Data Hold Time                                                                            | 15                 |       | 15                 |       |      | 12   |
| t <sub>DHR</sub>  | Data Hold Time referenced to $\overline{RAS}$                                             | 55                 |       | 70                 |       |      |      |
| t <sub>WCS</sub>  | Write Command Set-Up Time                                                                 | 0                  |       | 0                  |       |      | 13   |
| t <sub>RWD</sub>  | $\overline{RAS}$ to $\overline{WE}$ Delay Time                                            | 100                |       | 130                |       |      | 13   |
| t <sub>AWD</sub>  | Column Address to $\overline{WE}$ Delay Time                                              | 65                 |       | 80                 |       |      | 13   |
| t <sub>CV/D</sub> | $\overline{CAS}$ to $\overline{WE}$ Delay Time                                            | 45                 |       | 55                 |       |      | 13   |
| t <sub>DZC</sub>  | Data to $\overline{CAS}$ Delay Time                                                       | 0                  |       | 0                  |       |      |      |
| t <sub>DZO</sub>  | Data to $\overline{OE}$ Delay Time                                                        | 0                  |       | 0                  |       |      |      |
| t <sub>OEA</sub>  | Access Time from $\overline{OE}$                                                          |                    | 20    |                    | 25    |      | 8    |
| t <sub>OEZ</sub>  | Output Buffer Turn-off Delay from $\overline{OE}$                                         | 0                  | 10    | 0                  | 20    |      | 10   |
| t <sub>OZD</sub>  | $\overline{OE}$ to Data Delay Time                                                        | 10                 |       | 20                 |       |      |      |
| t <sub>OEH</sub>  | $\overline{OE}$ Command Hold Time                                                         | 10                 |       | 20                 |       |      |      |
| t <sub>ROH</sub>  | $\overline{RAS}$ Hold Time referenced to $\overline{OE}$                                  | 15                 |       | 15                 |       |      |      |
| t <sub>CSR</sub>  | $\overline{CAS}$ Set-Up Time for $\overline{CAS}$ Before $\overline{RAS}$ Cycle           | 10                 |       | 10                 |       | ms   |      |
| t <sub>CHR</sub>  | $\overline{CAS}$ Hold Time for $\overline{CAS}$ Before $\overline{RAS}$ Cycle             | 10                 |       | 10                 |       |      |      |
| t <sub>RPC</sub>  | $\overline{RAS}$ Precharge to $\overline{CAS}$ Active Time                                | 0                  |       | 0                  |       |      |      |
| t <sub>REF</sub>  | Refresh Period                                                                            |                    | 8     |                    | 8     |      |      |
| t <sub>WSR</sub>  | $\overline{WB}$ Set-Up Time                                                               | 0                  |       | 0                  |       |      |      |
| t <sub>RWH</sub>  | $\overline{WB}$ Hold Time                                                                 | 15                 |       | 15                 |       |      |      |
| t <sub>FSR</sub>  | DSF Set-Up Time referenced to $\overline{RAS}$                                            | 0                  |       | 0                  |       |      |      |
| t <sub>RFH</sub>  | DSF Hold Time referenced to $\overline{RAS}$ (1)                                          | 15                 |       | 15                 |       |      |      |
| t <sub>FHR</sub>  | DSF Hold Time referenced to $\overline{RAS}$ (2)                                          | 55                 |       | 70                 |       |      |      |
| t <sub>FSC</sub>  | DSF Set-Up Time referenced to $\overline{CAS}$                                            | 0                  |       | 0                  |       |      |      |
| t <sub>CFH</sub>  | DSF Hold Time referenced to $\overline{CAS}$                                              | 15                 |       | 15                 |       |      |      |
| t <sub>MS</sub>   | Write-Per-Bit Mask Data Set-Up Time                                                       | 0                  |       | 0                  |       |      |      |
| t <sub>MH</sub>   | Write-Per-Bit Mask Data Hold Time                                                         | 15                 |       | 15                 |       |      |      |
| t <sub>THS</sub>  | $\overline{DT}$ High Set-Up Time                                                          | 0                  |       | 0                  |       |      |      |
| t <sub>THH</sub>  | $\overline{DT}$ High Hold Time                                                            | 15                 |       | 15                 |       |      |      |
| t <sub>LS</sub>   | $\overline{DT}$ Low Set-Up Time                                                           | 0                  |       | 0                  |       |      |      |
| t <sub>LLH</sub>  | $\overline{DT}$ Low Hold Time                                                             | 15                 | 10000 | 15                 | 10000 |      |      |
| t <sub>RTH</sub>  | $\overline{DT}$ Low Hold Time referenced to $\overline{RAS}$<br>(Real Time Read Transfer) | 65                 | 10000 | 80                 | 10000 |      |      |
| t <sub>ATH</sub>  | $\overline{DT}$ Low Hold Time referenced to Column<br>Address (Real Time Read Transfer)   | 30                 |       | 30                 |       |      |      |
| t <sub>CTH</sub>  | $\overline{DT}$ Low Hold Time referenced to $\overline{CAS}$<br>(Real Time Read Transfer) | 25                 |       | 25                 |       |      |      |

# TC524259BJ/BZ-80, TC524259BJ/BZ-10

| SYMBOL            | PARAMETER                                                            | TC524259BJ/BZ-80 |      | TC524259BJ/BZ-10 |      | UNIT | NOTE |
|-------------------|----------------------------------------------------------------------|------------------|------|------------------|------|------|------|
|                   |                                                                      | MIN.             | MAX. | MIN.             | MAX. |      |      |
| t <sub>ESR</sub>  | SE Set-Up Time referenced to RAS                                     | 0                |      | 0                |      | ns   |      |
| t <sub>REH</sub>  | SE Hold Time referenced to RAS                                       | 15               |      | 15               |      |      |      |
| t <sub>TRP</sub>  | DT to RAS Precharge Time                                             | 60               |      | 70               |      |      |      |
| t <sub>TP</sub>   | DT Precharge Time                                                    | 20               |      | 30               |      |      |      |
| t <sub>RSD</sub>  | RAS to First SC Delay Time (Read Transfer)                           | 80               |      | 100              |      |      |      |
| t <sub>ASD</sub>  | Column Address to First SC Delay Time (Read Transfer)                | 45               |      | 50               |      |      |      |
| t <sub>CSN</sub>  | CAS to First SC Delay Time (Read Transfer)                           | 25               |      | 25               |      |      |      |
| t <sub>LSL</sub>  | Last SC to DT Load Time (Real Time Read Transfer)                    | 5                |      | 5                |      |      |      |
| t <sub>TSN</sub>  | DT to First SC Delay Time (Read Transfer)                            | 15               |      | 15               |      |      |      |
| t <sub>SRS</sub>  | Last SC to RAS Set-Up Time (Serial Input)                            | 30               |      | 30               |      |      |      |
| t <sub>SND</sub>  | RAS to First SC Delay Time (Serial Input)                            | 25               |      | 25               |      |      |      |
| t <sub>SDD</sub>  | RAS to Serial Input Delay Time                                       | 50               |      | 50               |      |      |      |
| t <sub>SDZ</sub>  | Serial Output Buffer Turn-off Delay from RAS (Pseudo Write Transfer) | 10               | 50   | 10               | 50   |      | 10   |
| t <sub>SCC</sub>  | SC Cycle Time                                                        | 30               |      | 30               |      |      |      |
| t <sub>SC</sub>   | SC Pulse Width (SC High Time)                                        | 10               |      | 10               |      |      |      |
| t <sub>SCP</sub>  | SC Precharge Time (SC Low Time)                                      | 10               |      | 10               |      |      |      |
| t <sub>SCA</sub>  | Access Time from SC                                                  |                  | 25   |                  | 25   |      | 9    |
| t <sub>SOH</sub>  | Serial Output Hold Time from SC                                      | 5                |      | 5                |      |      |      |
| t <sub>SDS</sub>  | Serial Input Set-Up Time                                             | 0                |      | 0                |      |      |      |
| t <sub>SDH</sub>  | Serial Input Hold Time                                               | 15               |      | 15               |      |      |      |
| t <sub>SEA</sub>  | Access Time from SE                                                  |                  | 25   |                  | 25   |      | 9    |
| t <sub>SE</sub>   | SE Pulse Width                                                       | 25               |      | 25               |      |      |      |
| t <sub>SEP</sub>  | SE Precharge Time                                                    | 25               |      | 25               |      |      |      |
| t <sub>SEZ</sub>  | Serial Output Buffer Turn-off Delay from SE                          | 0                | 20   | 0                | 20   |      | 10   |
| t <sub>SEI</sub>  | Serial Input to SE Delay Time                                        | 0                |      | 0                |      |      |      |
| t <sub>SZS</sub>  | Serial Input to First SC Delay Time                                  | 0                |      | 0                |      |      |      |
| t <sub>SWs</sub>  | Serial Write Enable Set-Up Time                                      | 0                |      | 0                |      |      |      |
| t <sub>SWH</sub>  | Serial Write Enable Hold Time                                        | 15               |      | 15               |      |      |      |
| t <sub>SWIS</sub> | Serial Write Disable Set-Up Time                                     | 0                |      | 0                |      |      |      |
| t <sub>SWIH</sub> | Serial Write Disable Hold Time                                       | 15               |      | 15               |      |      |      |
| t <sub>STS</sub>  | Split Transfer Set-Up Time                                           | 30               |      | 30               |      |      |      |
| t <sub>STH</sub>  | Split Transfer Hold Time                                             | 30               |      | 30               |      |      |      |
| t <sub>SDQ</sub>  | SC - QSF Delay Time                                                  |                  | 60   |                  | 60   |      | 16   |

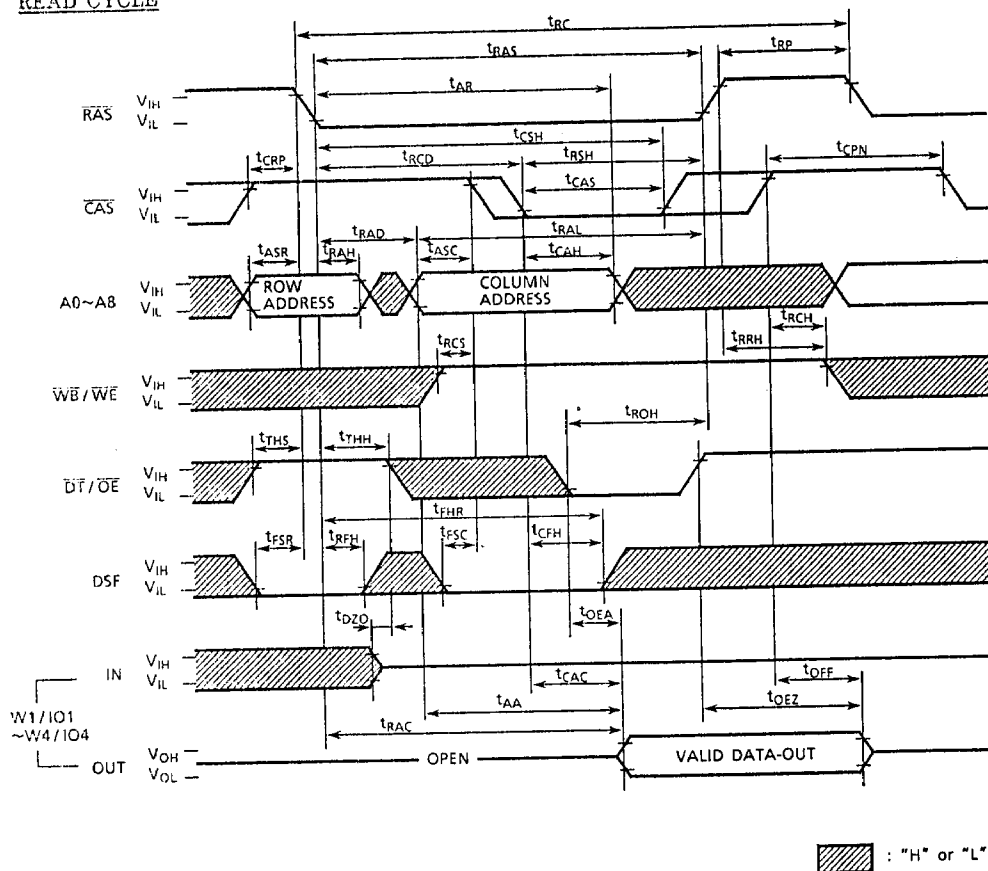
## NOTES :

1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.
2. All voltage are referenced to  $V_{SS}$ .
3. These parameters depend on cycle rate.
4. These parameters depend on output loading. Specified values are obtained with the output open.
5. An initial pause of 200 $\mu$ s is required after power-up followed by any 8  $\overline{RAS}$  cycles ( $\overline{DT}/\overline{OE}$  "high") and any 8 SC cycles before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8  $\overline{CAS}$  before  $\overline{RAS}$  initialization cycles instead of 8  $\overline{RAS}$  cycles are required.
6. AC measurements assume  $t_r=5$ ns.
7.  $V_{IH(min.)}$  and  $V_{IL(max.)}$  are reference levels for measuring timing of input signals. Also, transition times are measured between  $V_{IH}$  and  $V_{IL}$ .
8. RAM port outputs are measured with a load equivalent to 1 TTL load and 100pF.  
DO<sub>UT</sub> reference levels :  $V_{OH}/V_{OL}=2.0V/0.8V$ .
9. SAM port outputs are measured with a load equivalent to 1 TTL load and 30pF.  
DO<sub>UT</sub> reference levels :  $V_{OH}/V_{OL}=2.0V/0.8V$ .
10.  $t_{OFF(max.)}$ ,  $t_{OEZ(max.)}$ ,  $t_{SDZ(max.)}$  and  $t_{SEZ(max.)}$  define the time at which the outputs achieve the open circuit condition and are not referenced to output voltage levels.
11. Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for a read cycles.
12. These parameters are referenced to  $\overline{CAS}$  leading edge of early write cycles and to  $\overline{WB}/\overline{WE}$  leading edge in  $\overline{OE}$ -controlled-write cycles and read-modify-write cycles.
13.  $t_{WCS}$ ,  $t_{RWd}$ ,  $t_{CWD}$  and  $t_{AWd}$  are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only. If  $t_{WCS} \geq t_{WCS(min.)}$ , the cycle is an early write cycles and the data out pin will remain open circuit (high impedance) throughout the entire cycle; If  $t_{RWd} \geq t_{RWd(min.)}$ ,  $t_{CWD} \geq t_{CWD(min.)}$  and  $t_{AWd} \geq t_{AWd(min.)}$  the cycle is a read-modify-write cycle and the data out will contain data read from the selected cell: If neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
14. Operation within the  $t_{RCD(max.)}$  limit insures that  $t_{RAC(max.)}$  can be met.  
 $t_{RCD(max.)}$  is specified as a reference point only: If  $t_{RCD}$  is greater than the specified  $t_{RCD(max.)}$  limit, then access time is controlled by  $t_{CAC}$ .
15. Operation within the  $t_{RAD(max.)}$  limit insures that  $t_{RAC(max.)}$  can be met.  $t_{RAD(max.)}$  is specified as a reference point only: If  $t_{RAD}$  is greater than the specified  $t_{RAD(max.)}$  limit, then access time is controlled by  $t_{AA}$ .
16. This parameter measurement assumes Pull up resistor = 820 $\Omega$ .



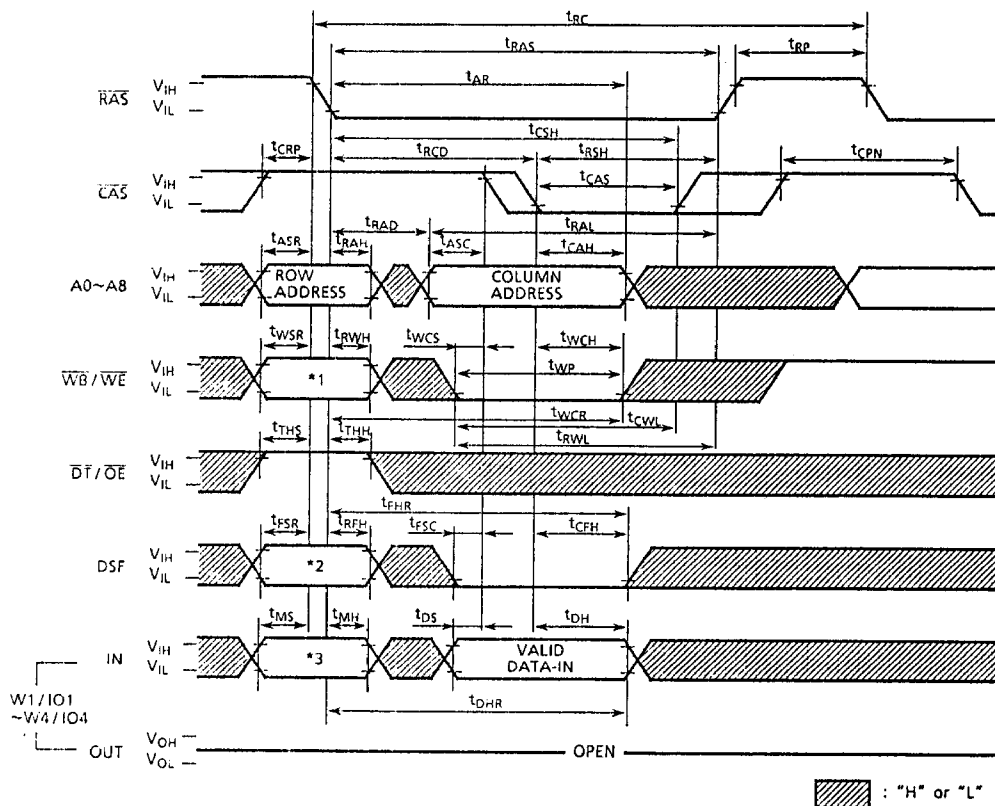
# TIMING WAVEFORM

## READ CYCLE



# TC524259BJ/BZ-80, TC524259BJ/BZ-10

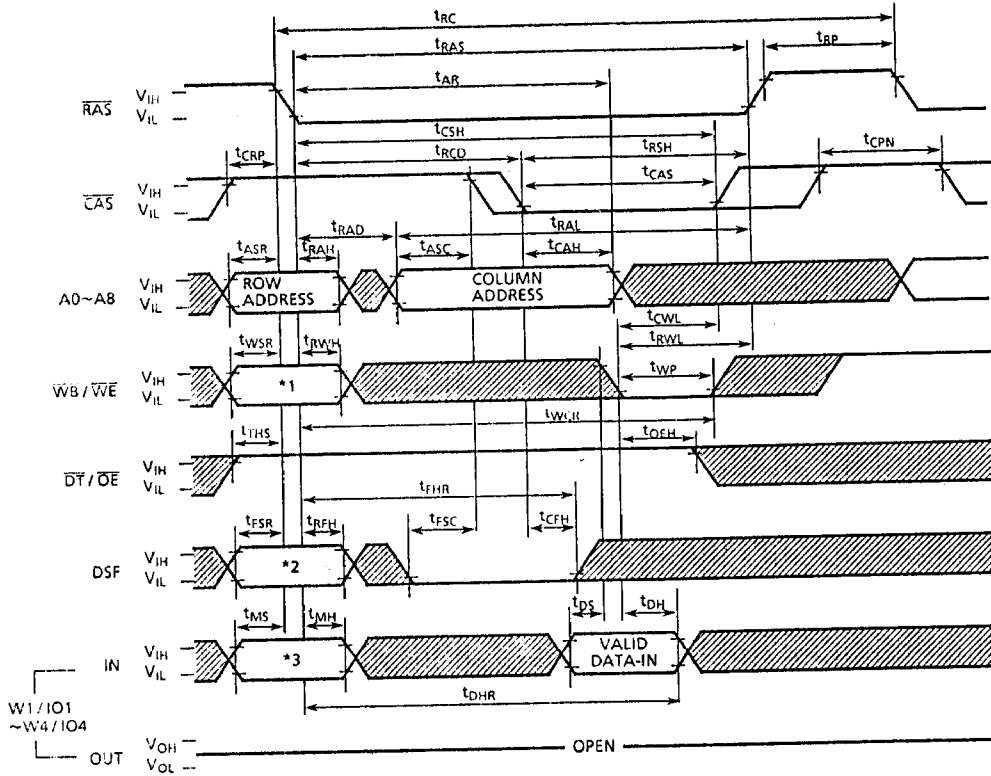
## WRITE CYCLE (EARLY WRITE)



| *1 $\overline{WB}/\overline{WE}$ | *2 DSF | *3 W1/IO1 ~ W4/IO4 | Cycle                           |
|----------------------------------|--------|--------------------|---------------------------------|
| 0                                | 0      | WM1 data           | Write per bit 1 (New Mask Mode) |
|                                  | 1      | Don't Care         | Write per bit 2 (Old Mask Mode) |
| 1                                | 0      | Don't Care         | Normal Write (No Mask Mode)     |

WM1 data: 0: Write Disable  
1: Write Enable

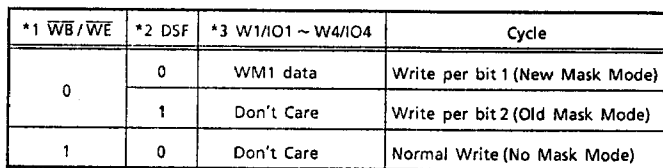
## WRITE CYCLE ( $\overline{OE}$ CONTROLLED WRITE)



| *1 $\overline{WB}/\overline{WE}$ | *2 DSF | *3 W1/IO1 ~ W4/IO4 | Cycle                           |
|----------------------------------|--------|--------------------|---------------------------------|
| 0                                | 0      | WM1 data           | Write per bit 1 (New Mask Mode) |
|                                  | 1      | Don't Care         | Write per bit 2 (Old Mask Mode) |
| 1                                | 0      | Don't Care         | Normal Write (No Mask Mode)     |

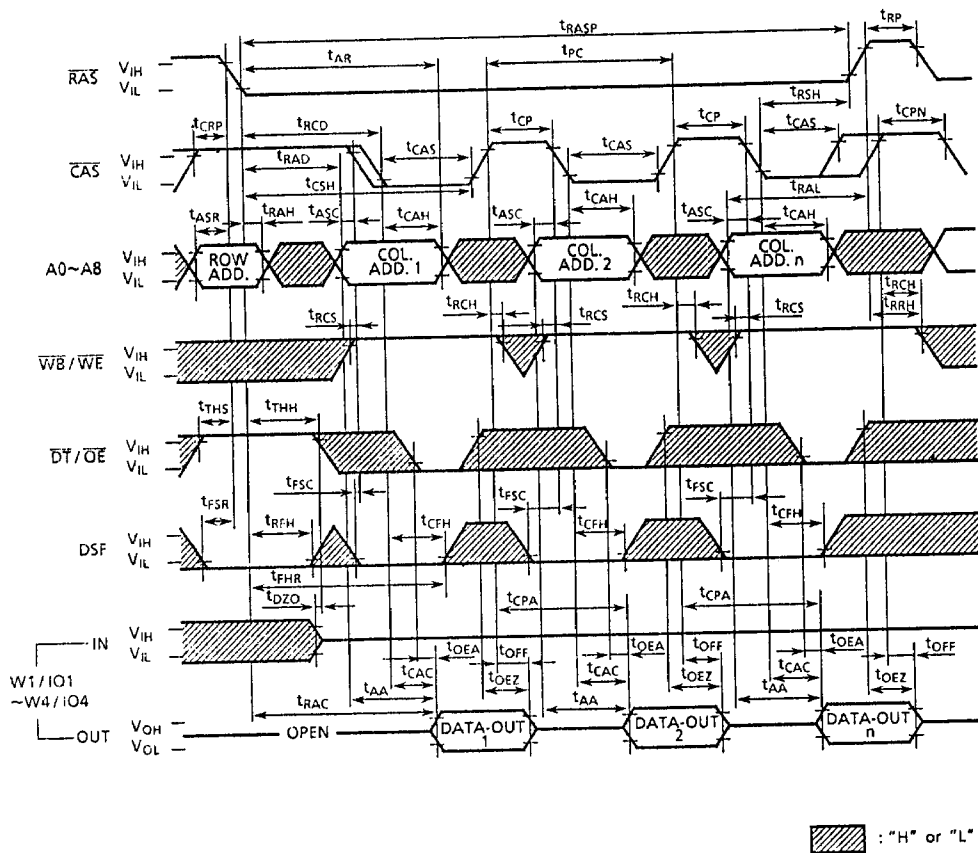
WM1 data : 0: Write Disable  
1: Write Enable

### READ - MODIFY - WRITE CYCLE



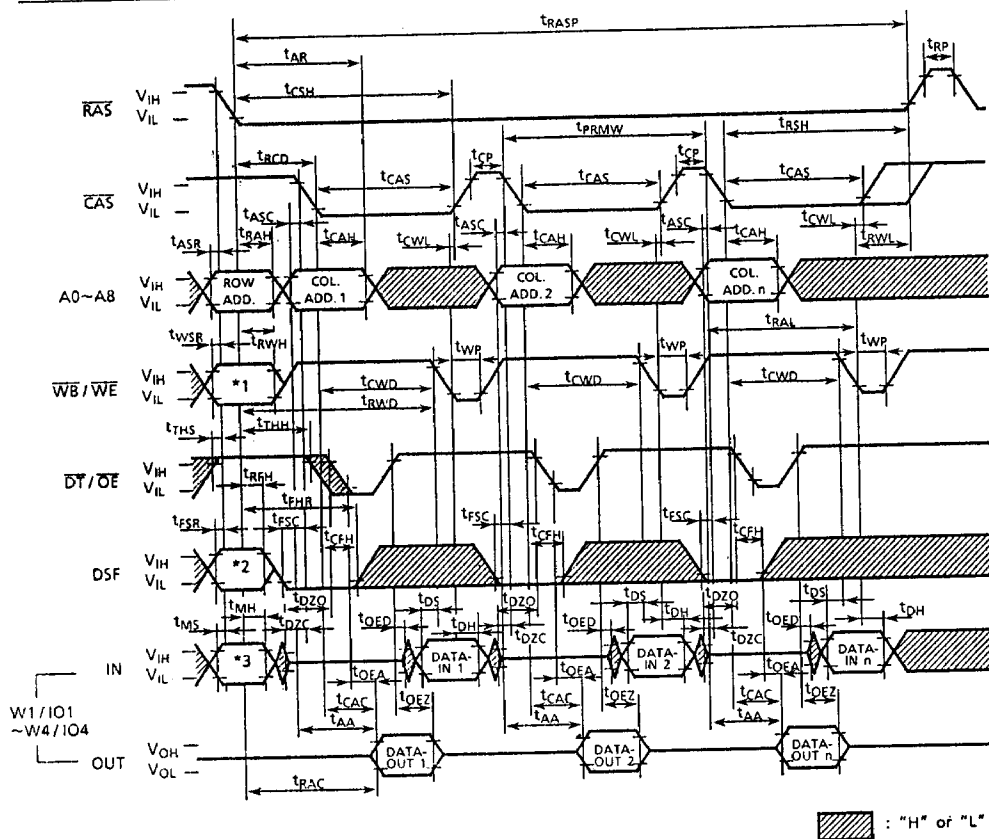
C-202

## FAST PAGE MODE READ CYCLE





FAST PAGE MODE READ-MODIFY-WRITE CYCLE

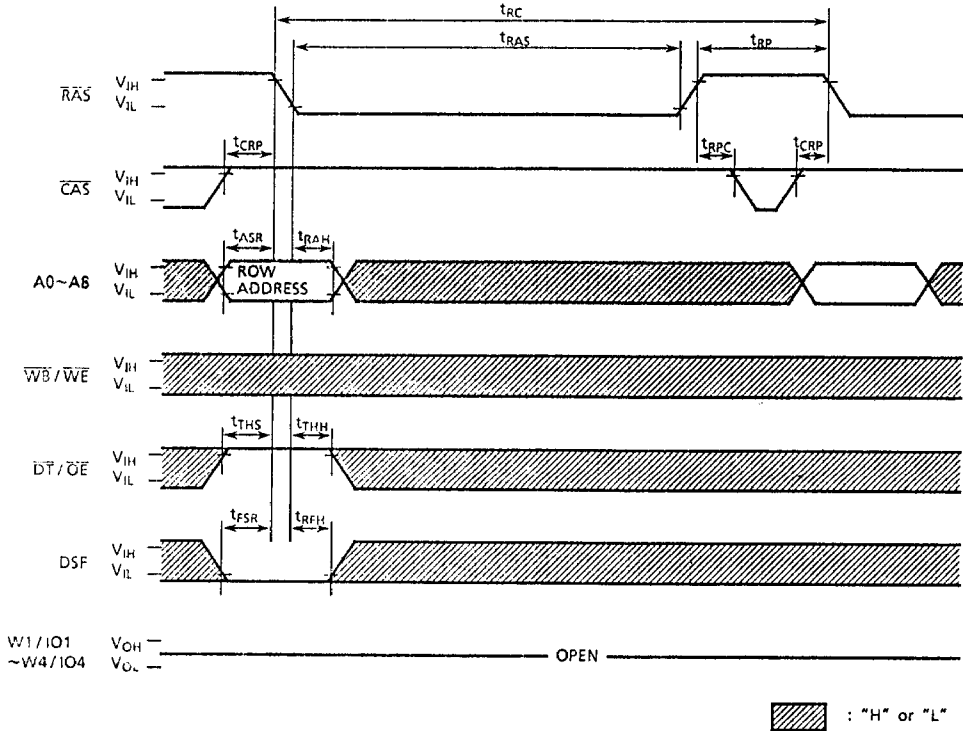


| *1 WB/WE | *2 DSF | *3 W1/IO1 ~ W4/IO4 | Cycle                           |
|----------|--------|--------------------|---------------------------------|
| 0        | 0      | WM1 data           | Write per bit 1 (New Mask Mode) |
|          | 1      | Don't Care         | Write per bit 2 (Old Mask Mode) |
| 1        | 0      | Don't Care         | Normal Write (No Mask Mode)     |

WM1 data: 0: Write Disable  
1: Write Enable

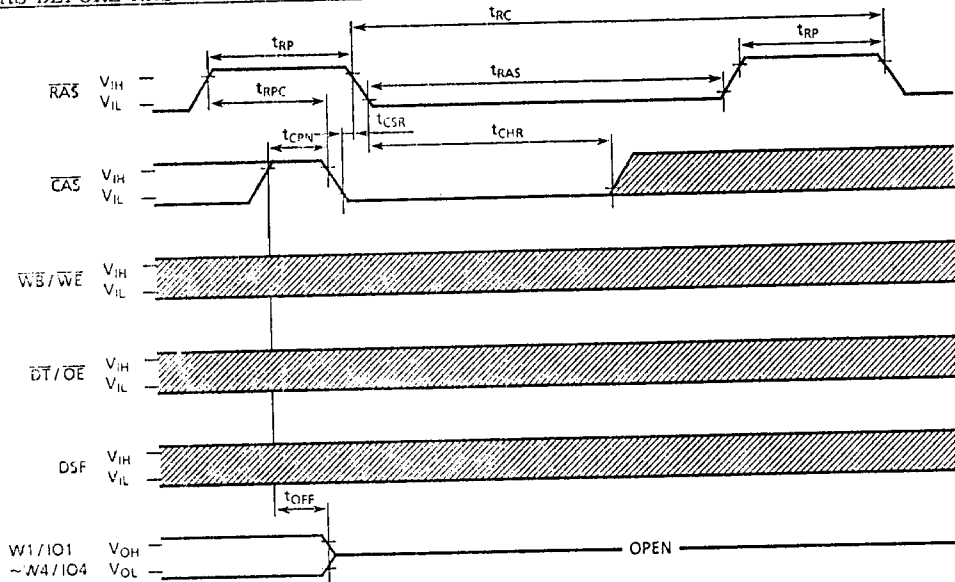
TC524259BJ/BZ-80, TC524259BJ/BZ-10

RAS ONLY REFRESH CYCLE





CAS BEFORE RAS REFRESH CYCLE

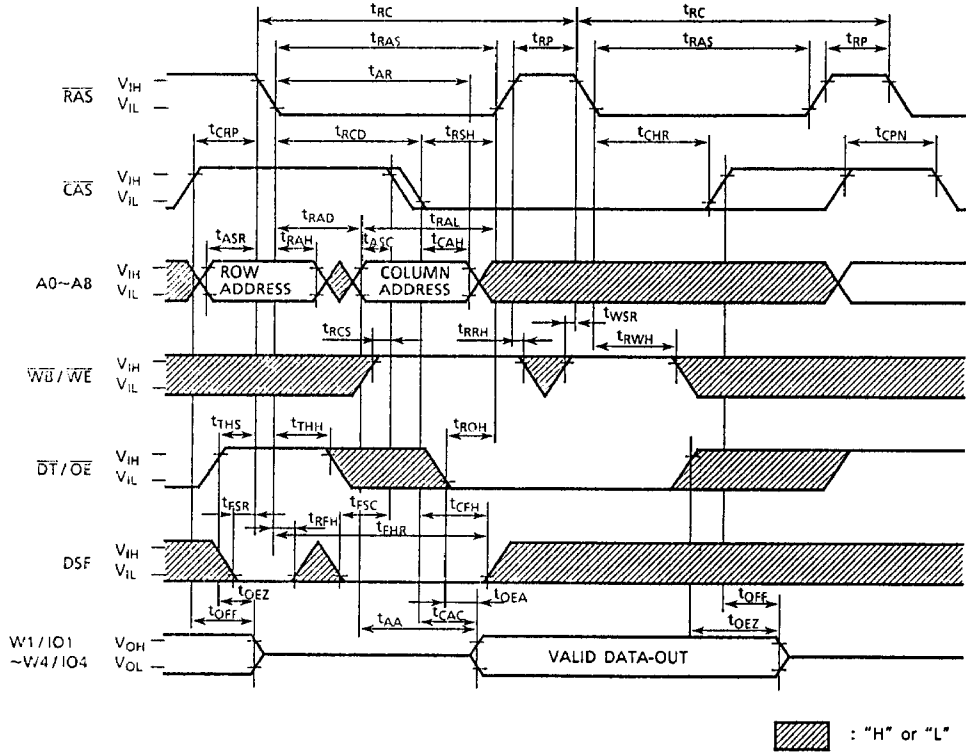


Note : A0 - A8 = Don't Care ("H" or "L")

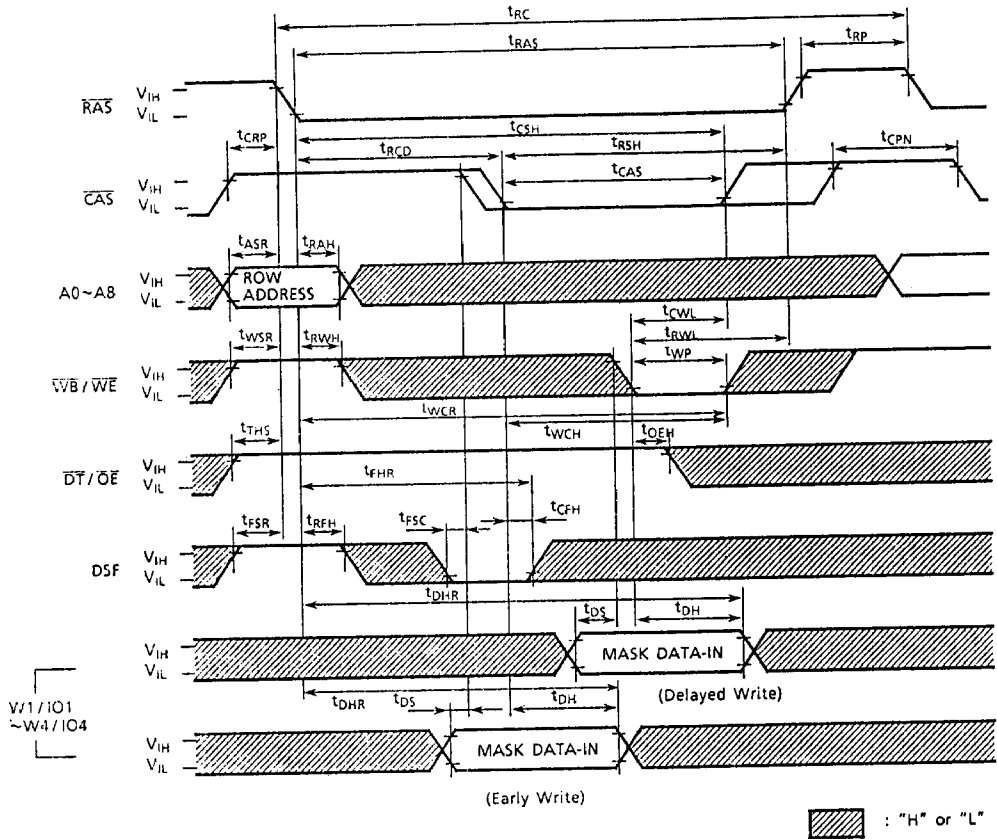
 : "H" or "L"

# TC524259BJ/BZ-80, TC524259BJ/BZ-10

## HIDDEN REFRESH CYCLE

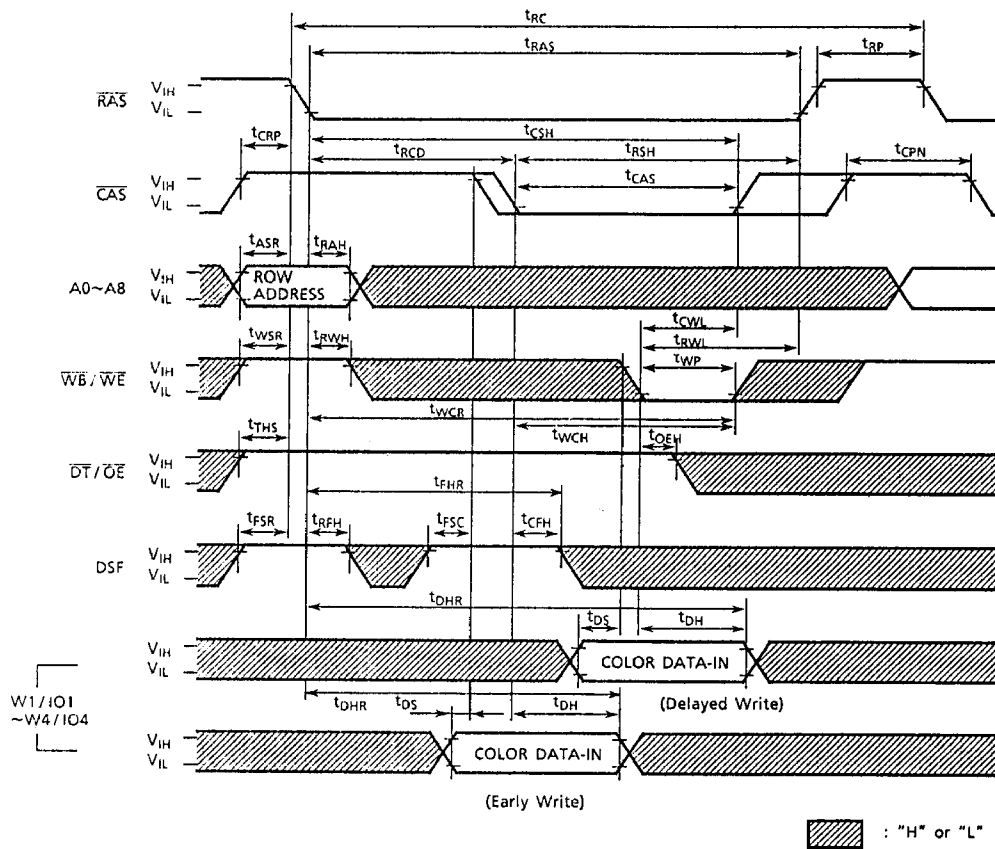


LOAD MASK REGISTER CYCLE

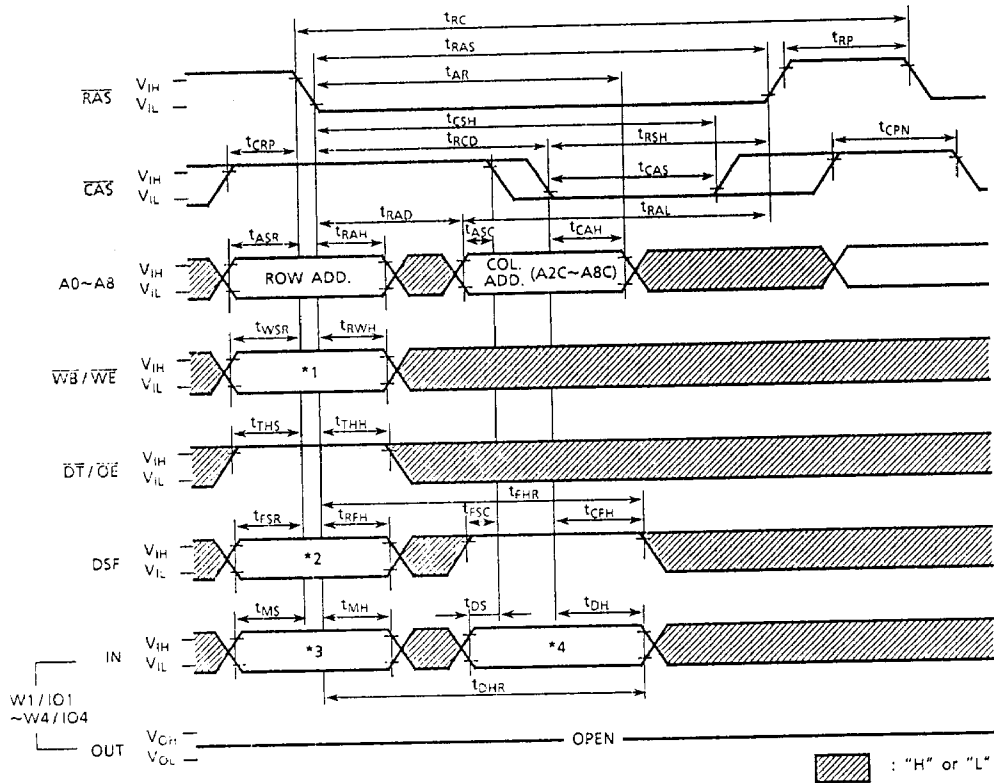


# TC524259BJ/BZ-80, TC524259BJ/BZ-10

## LOAD COLOR REGISTER CYCLE



## BLOCK WRITE CYCLE



| *1 WB/WE | *2 DSF | *3 W1/IO1 ~ W4/IO4 | Cycle                                |
|----------|--------|--------------------|--------------------------------------|
| 0        | 0      | WM1 data           | Block Write (Mask 1) (New Mask Mode) |
|          | 1      | Don't Care         | Block Write (Mask 2) (Old Mask Mode) |
| 1        | 0      | Don't Care         | Block Write (No Mask Mode)           |

WM1 data: 0: Write Disable  
1: Write Enable

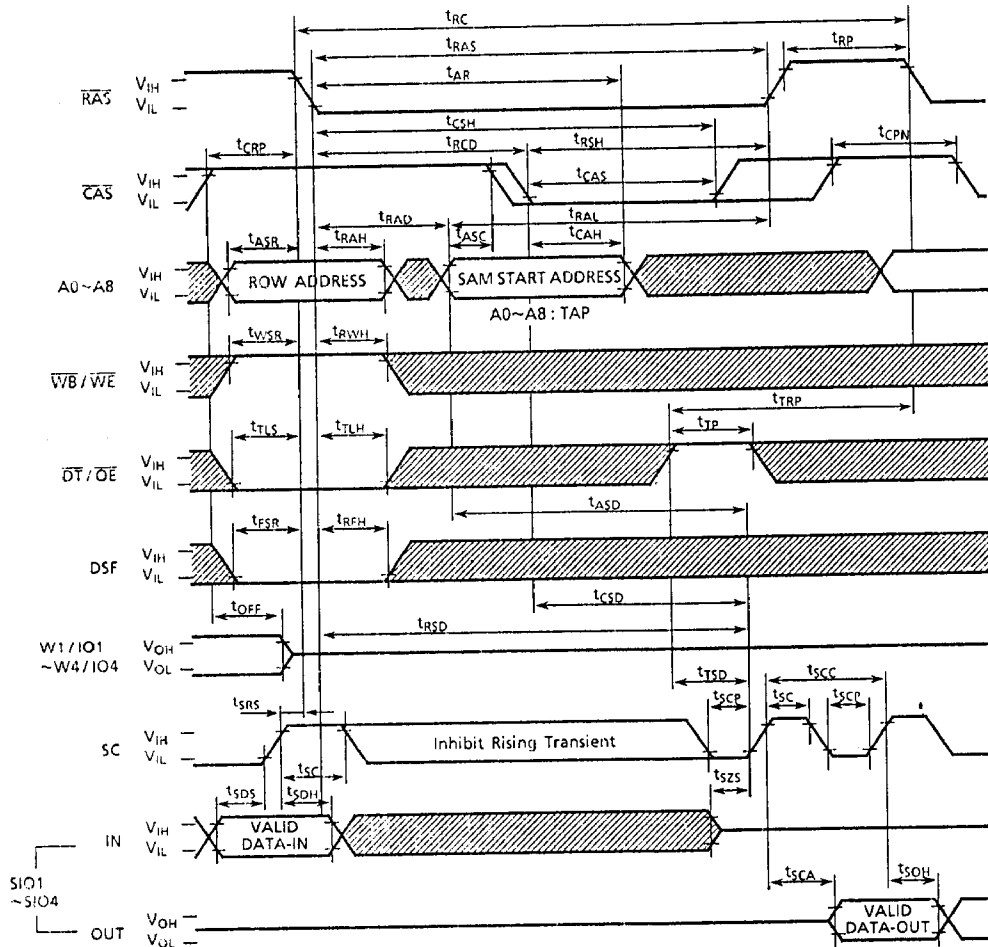
### \*4) COLUMN SELECT

W1/IO1 — Column 0 (A1C=0, A0C=0)  
 W2/IO2 — Column 1 (A1C=0, A0C=1)  
 W3/IO3 — Column 2 (A1C=1, A0C=0)  
 W4/IO4 — Column 3 (A1C=1, A0C=1)

Wn/ION  
 = 0 : Disable  
 = 1 : Enable



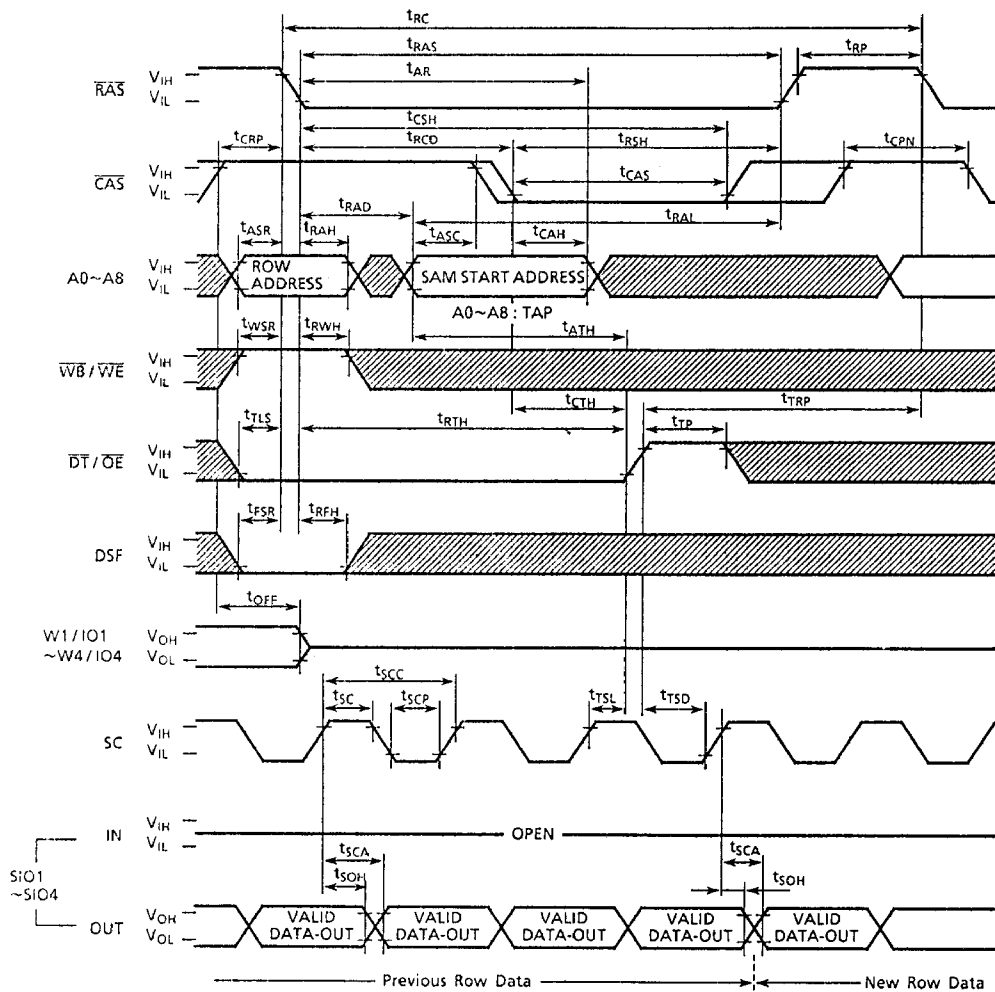
## READ TRANSFER CYCLE (Previous Transfer is WRITE TRANSFER CYCLE)



Note :  $\overline{SE} = V_{IL}$

▨ : "H" or "L"

## REAL TIME READ TRANSFER CYCLE

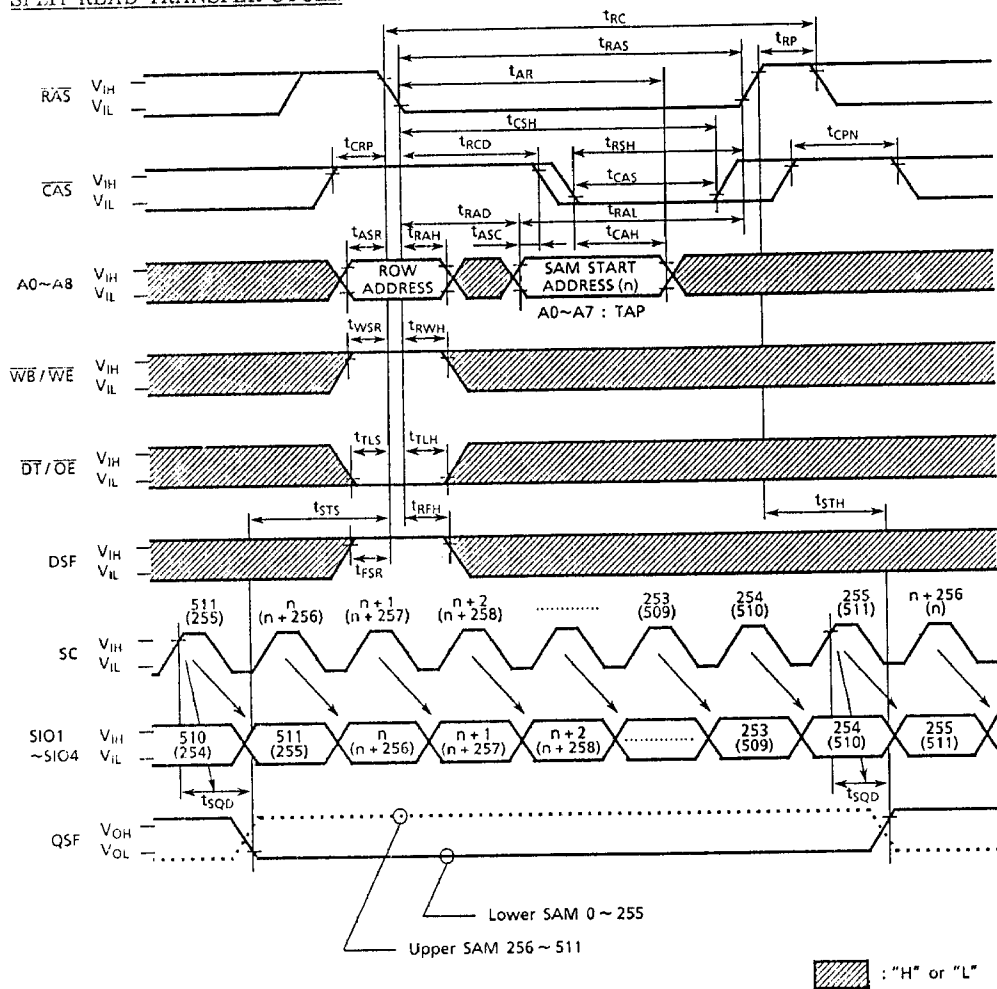


Note :  $\overline{SE} = V_{IL}$

▨ : "H" or "L"



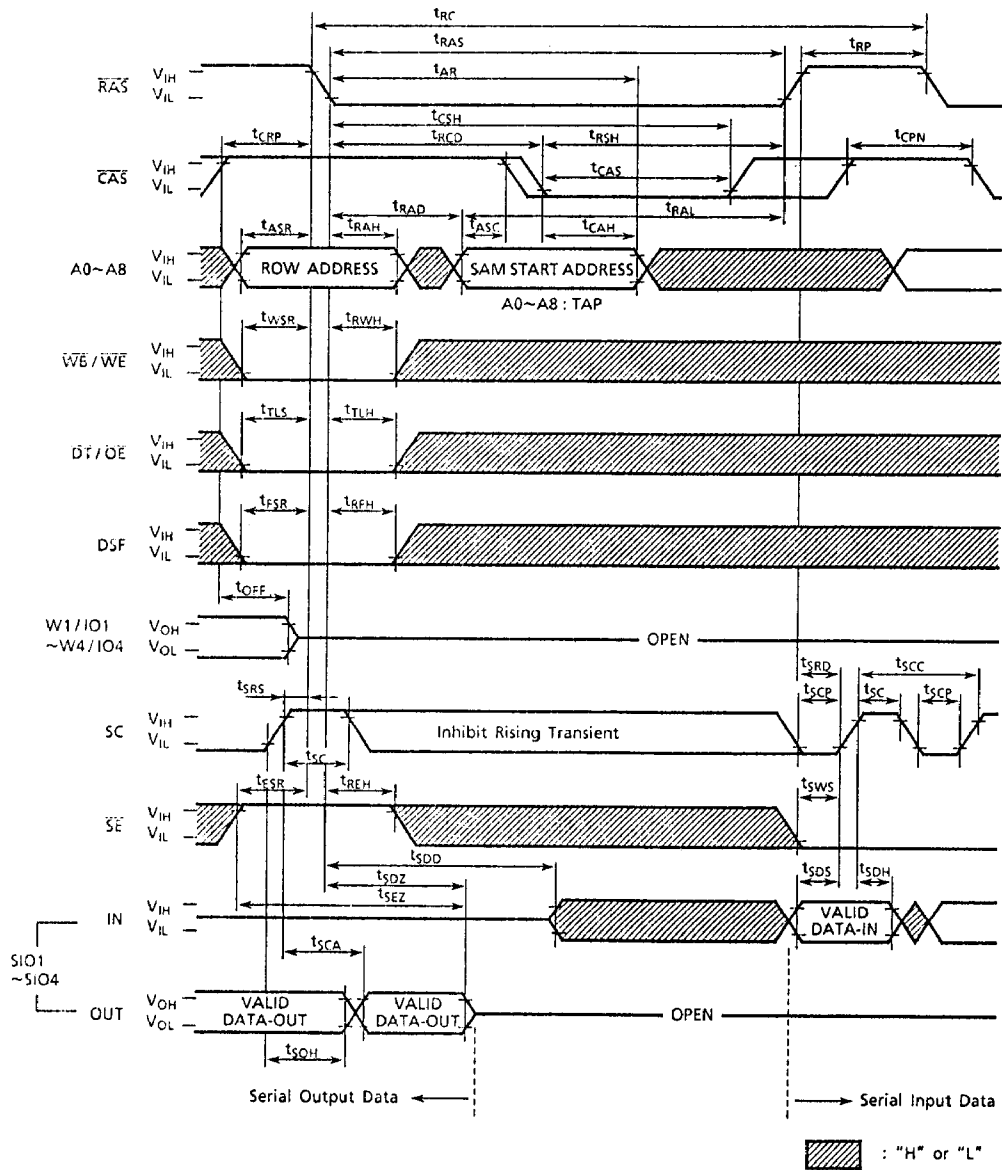
## SPLIT READ TRANSFER CYCLE



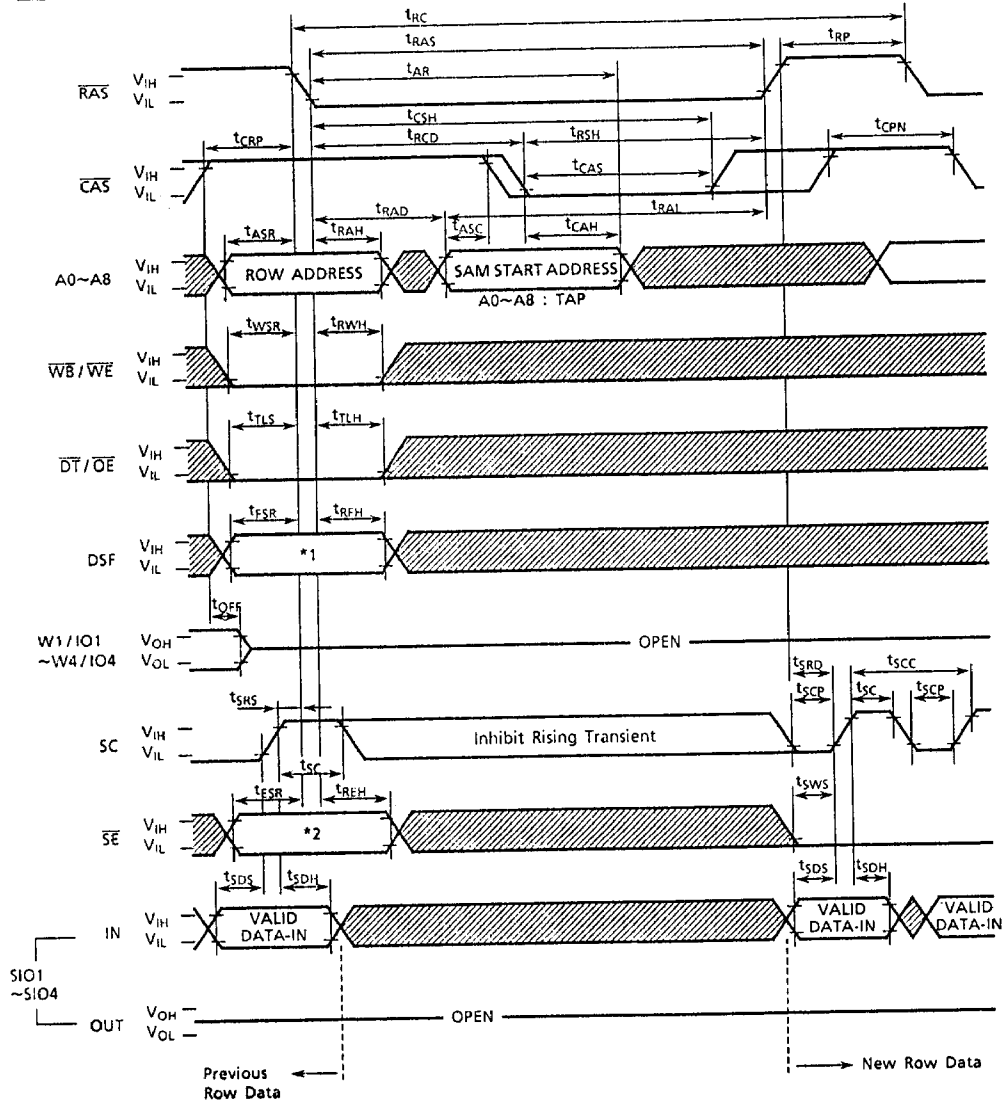
Note :  $\overline{SE} = V_{IL}$

# TC524259BJ/BZ-80, TC524259BJ/BZ-10

## PSEUDO WRITE TRANSFER CYCLE



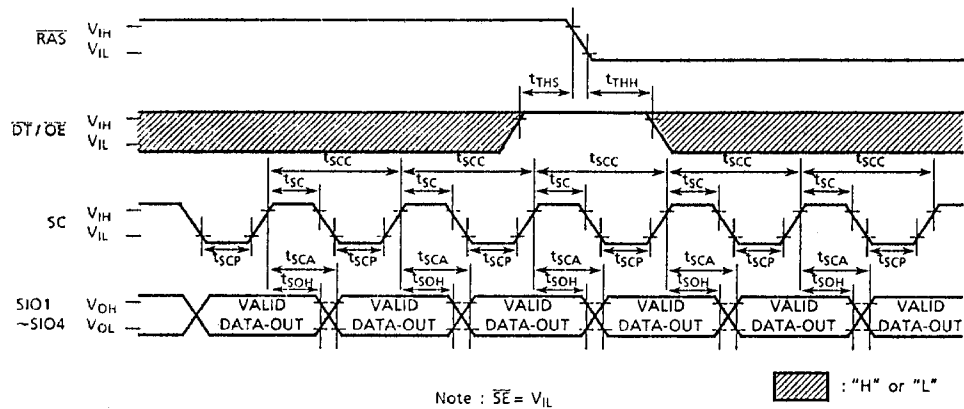
WRITE TRANSFER CYCLE



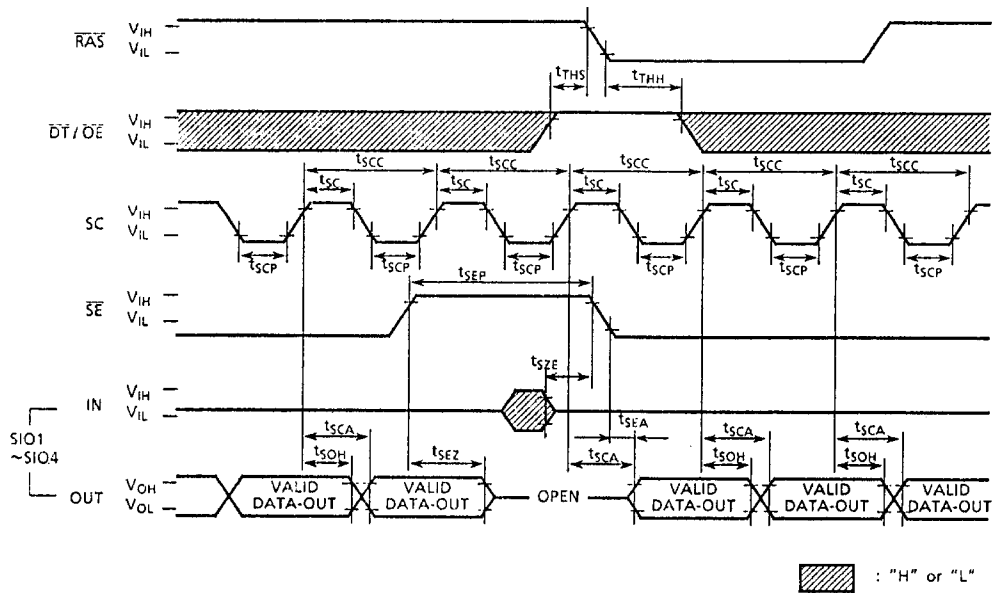
| *1 DSF | *2 SE | Cycle          |
|--------|-------|----------------|
| 0      | 0     | Write Transfer |
| 1      | *     | Write Transfer |

# TC524259BJ/BZ-80, TC524259BJ/BZ-10

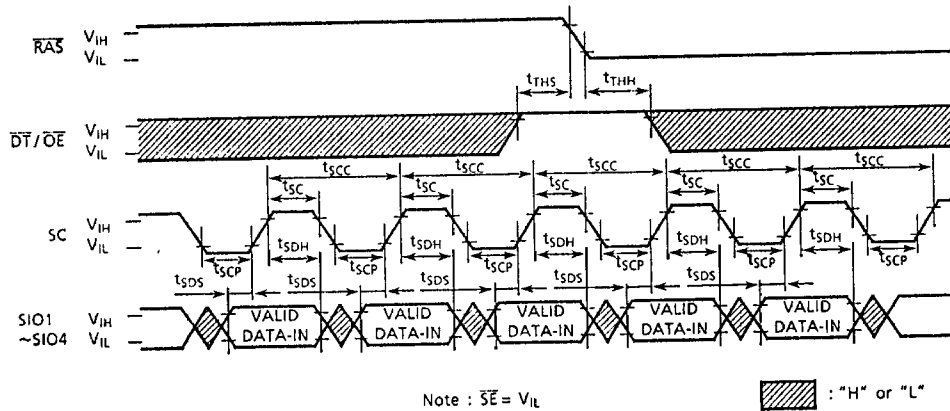
## SERIAL READ CYCLE ( $\overline{SE} = V_{IL}$ )



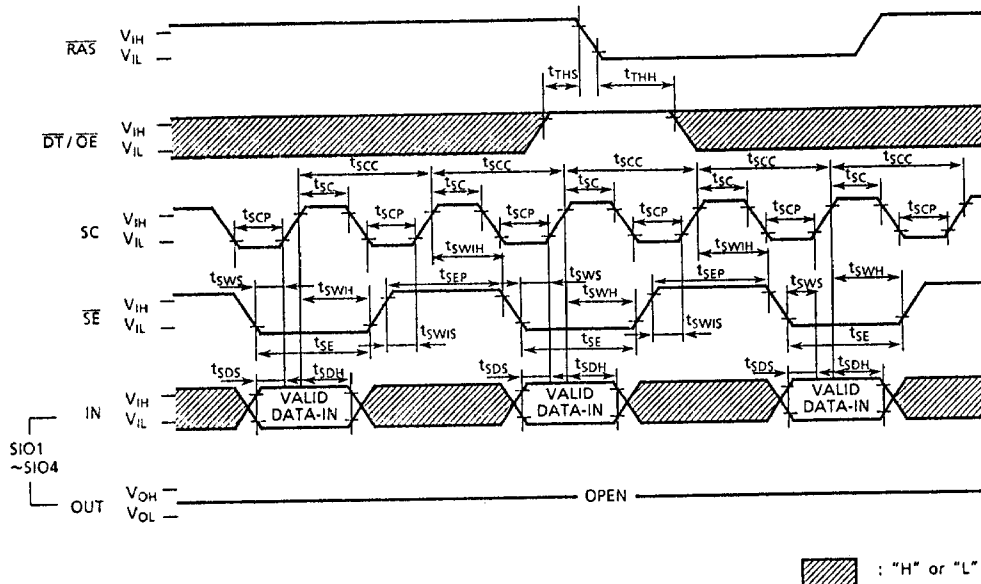
## SERIAL READ ( $\overline{SE}$ Control Outputs)



## SERIAL WRITE CYCLE ( $\overline{SE} = V_{IL}$ )



## SERIAL WRITE ( $\overline{SE}$ Controlled Inputs)



# TC524259BJ/BZ-80, TC524259BJ/BZ-10

## PIN FUNCTION

### ADDRESS INPUTS : $A_0 \sim A_8$

The 18 address bits required to decode 4 bits of the 1,048,576 cell locations within the dynamic RAM memory array of the TC524259BJ/BZ are multiplexed onto 9 address input pins ( $A_0 \sim A_8$ ). Nine row address bits are latched on the falling edge of the row address strobe ( $\overline{RAS}$ ) and the following nine column address bits are latched on the falling edge of the column address strobe ( $\overline{CAS}$ ).

### ROW ADDRESS STROBE : $\overline{RAS}$

A random access cycle or a data transfer cycle begins at the falling edge of  $\overline{RAS}$ .  $\overline{RAS}$  is the control input that latches the row address bits and the states of  $\overline{CAS}$ ,  $\overline{DT}/\overline{OE}$ ,  $\overline{WB}/\overline{WE}$ ,  $\overline{SE}$  and  $\overline{DSF}$  to invoke the various random access and data transfer operating modes shown in Table 2.  $\overline{RAS}$  has minimum and maximum pulse widths and a minimum precharge requirement which must be maintained for proper device operation and data integrity. The RAM port is placed in standby mode when the  $\overline{RAS}$  control is held "high".

### COLUMN ADDRESS STROBE : $\overline{CAS}$

$\overline{CAS}$  is the control input that latches the column address bits and the state of the special function input  $\overline{DSF}$  to select, in conjunction with the  $\overline{RAS}$  control, either read/write operations or the special block write feature on the RAM port when the  $\overline{DSF}$  input is held "low" at the falling edge of  $\overline{RAS}$ . Refer to the operation truth table shown in Table 1.  $\overline{CAS}$  has minimum and maximum pulse widths and a minimum precharge requirement which must be maintained for proper device operation and data integrity.  $\overline{CAS}$  also acts as an output enable for the output buffers on the RAM port.

### DATA TRANSFER/OUTPUT ENABLE : $\overline{DT}/\overline{OE}$

The  $\overline{DT}/\overline{OE}$  input is a multifunction pin. When  $\overline{DT}/\overline{OE}$  is "high" at the falling edge of  $\overline{RAS}$ , RAM port operations are performed and  $\overline{DT}/\overline{OE}$  is used as an output enable control. When the  $\overline{DT}/\overline{OE}$  is "low" at the falling edge of  $\overline{RAS}$ , a data transfer operation is started between the RAM port and the SAM port.

#### WRITE PER BIT/WRITE ENABLE : $\overline{WB}/\overline{WE}$

The  $\overline{WB}/\overline{WE}$  input is also a multifunction pin. When  $\overline{WB}/\overline{WE}$  is "high" at the falling edge of  $\overline{RAS}$ , during RAM port operations, it is used to write data into the memory array in the same manner as a standard DRAM. When  $\overline{WB}/\overline{WE}$  is "low" at the falling edge of  $\overline{RAS}$ , during RAM port operations, the write-per-bit function is enabled. The  $\overline{WB}/\overline{WE}$  input also determines the direction of data transfer between the RAM array and the serial register (SAM). When  $\overline{WB}/\overline{WE}$  is "high" at the falling edge of  $\overline{RAS}$ , the data is transferred from RAM to SAM (read transfer). When  $\overline{WB}/\overline{WE}$  is "low" at the falling edge of  $\overline{RAS}$ , the data is transferred from SAM to RAM (write transfer).

#### WRITE MASK DATA/DATA INPUT AND OUTPUT : $W_1/IO_1 \sim W_4/IO_4$

When the write-per-bit (New Mask Mode) function is enabled, the mask data on the  $W_i/IO_i$  pins is latched into the write mask register (WM1) at the falling edge of  $\overline{RAS}$ . Data is written into the DRAM on data lines where the write-mask data is a logic "1". Writing is inhibited on data lines where the write-mask data is a logic "0". The write-mask data is valid for only one cycle. Data is written into the RAM port during a write or read-modify-write cycle. The input data is latched at the falling edge of either  $\overline{CAS}$  or  $\overline{WB}/\overline{WE}$ , whichever occurs late. During an early-write cycle, the outputs are in the high-impedance state. Data is read out of the RAM port during a read or read-modify-write cycle. The output data becomes valid on the  $W_i/IO_i$  pins after the specified access times from  $\overline{RAS}$ ,  $\overline{CAS}$ ,  $\overline{DT}/\overline{OE}$  and column address are satisfied and will remain valid as long as  $\overline{CAS}$  and  $\overline{DT}/\overline{OE}$  are kept "low". The outputs will return to the high-impedance state at the rising edge of either  $\overline{CAS}$  or  $\overline{DT}/\overline{OE}$ , whichever occurs first.

#### SERIAL CLOCK : SC

All operations of the SAM port are synchronized with the serial clock SC. Data is shifted in or out of the SAM registers at the rising edge of SC. In a serial read, the output data becomes valid on the SIO pins after the maximum specified serial access time  $t_{SCA}$  from the rising edge of SC. The serial clock SC also increments the 9-bits serial pointer (8-bits in split register mode) which is used to select the SAM address. The pointer address is incremented in a wrap-around mode to select sequential locations after the starting location which is determined by the column address in the read transfer cycle. When the pointer reaches the most significant address location (decimal 511), the next SC clock will place it at the least significant address location (decimal 0). The serial clock SC must be held at a constant  $V_{IH}$  or  $V_{IL}$  level during read/pseudo write/write transfer operations and should not be clocked while the SAM port is in the standby mode to prevent the SAM pointer from being incremented.

## SERIAL ENABLE : $\overline{SE}$

The  $\overline{SE}$  input is used to enable serial access operation. In a serial read cycle,  $\overline{SE}$  is used as an output control. In a serial write cycle,  $\overline{SE}$  is used as a write enable control. When  $\overline{SE}$  is "high", serial access is disabled, however, the serial address pointer location is still incremented when SC is clocked even when  $\overline{SE}$  is "high".

## SPECIAL FUNCTION CONTROL INPUT : DSF

The DSF input is latched at the falling edge of  $\overline{RAS}$  and  $\overline{CAS}$  and allows for the selection of various random port and data transfer operating modes. In addition to the conventional multiport DRAM, the special features consisting of write per bit 2, block write, block write (mask 1 & 2), load color/mask register and split read transfer can be invoked.

## SPECIAL FUNCTION OUTPUT : QSF

QSF is an open drain output signal which, during split register operation, indicates which half of the split SAM is being accessed. Since QSF is an open drain output, it must be pulled up to VCC with an appropriate pull-up resistor. QSF "on" (low state) indicates that the lower split SAM (Bits 0 thru 255) is being accessed and QSF "off" (open state) indicates that the upper split SAM (Bits 256 thru 511) is being accessed. After the QSF has toggled to either an open or low state, a delay of  $t_{SPS}$  must be met before a split read transfer operation can be performed on the non-active half of the split SAM.

## SERIAL INPUT/OUTPUT : SIO1~SIO4

Serial input and serial output share common I/O pins. Serial input or output mode is determined by the most recent read, write or pseudo write transfer cycle. When a read transfer cycle is performed, the SAM port is in the output mode. When a write or pseudo write transfer cycle is performed, the SAM port is switched from output mode to input mode. During subsequent write transfer cycle, the SAM remains in the input mode.



## OPERATION MODE

The RAM port and data transfer operating of the TC524259BJ/BZ are determined by the state of  $\overline{\text{CAS}}$ ,  $\overline{\text{DT/OE}}$ ,  $\overline{\text{WB/WE}}$ ,  $\overline{\text{SE}}$  and  $\text{DSF}$  at the falling edge of  $\overline{\text{RAS}}$  and by the state of  $\text{DSF}$  at the falling edge of  $\overline{\text{CAS}}$ . The Table 1 and the Table 2 show the operation truth table and the functional truth table for a listing of all available RAM port and transfer operation, respectively.

Table 1. Operation Truth Table

| $\overline{\text{CAS}}$ falling edge  |           |           |    |   | DSF                                                            |                      |                       |                      |  |  |
|------------------------------------------------------------------------------------------------------------------------|-----------|-----------|----|---|----------------------------------------------------------------|----------------------|-----------------------|----------------------|--|--|
| $\overline{\text{RAS}}$ falling edge  |           |           |    |   |                                                                | DSF                  |                       |                      |  |  |
| $\overline{\text{CAS}}$                                                                                                | DT/<br>CE | WB/<br>WE | SE |   |                                                                |                      |                       |                      |  |  |
| 0                                                                                                                      | *         | *         | *  | * | 0                                                              | 0                    | 1                     | 1                    |  |  |
| 1                                                                                                                      | 0         | 0         | 0  | 0 | 0                                                              | 1                    | 0                     | 1                    |  |  |
|                                                                                                                        |           |           |    |   | $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ Refresh |                      |                       |                      |  |  |
| 1                                                                                                                      | 0         | 0         | 0  | 0 | Write Transfer                                                 | Write Transfer       | Write Transfer        | Write Transfer       |  |  |
| 1                                                                                                                      | 0         | 0         | 1  | * | Pseudo Write Transfer                                          |                      | Pseudo Write Transfer |                      |  |  |
| 1                                                                                                                      | 0         | 1         | *  | * | Read Transfer                                                  | Split Read Transfer  | Read Transfer         | Split Read Transfer  |  |  |
| 1                                                                                                                      | 1         | 0         | *  | * | Read/Write per Bit 1                                           | Read/Write per Bit 2 | Block Write (Mask 1)  | Block Write (Mask 2) |  |  |
| 1                                                                                                                      | 1         | 1         | *  | * | Read/Write                                                     | Load Mask            | Block Write           | Load Color           |  |  |

Table 2. Functional Truth Table

| Function                                                       | $\overline{\text{RAS}}$ |                           |                           |              |                        | $\overline{\text{CAS}}$ |                         | Address                 |                         | W/IO                    |                         |                        | Write Mask | Register |       |
|----------------------------------------------------------------|-------------------------|---------------------------|---------------------------|--------------|------------------------|-------------------------|-------------------------|-------------------------|-------------------------|-------------------------|-------------------------|------------------------|------------|----------|-------|
|                                                                | $\overline{\text{CAS}}$ | $\overline{\text{DT/OE}}$ | $\overline{\text{WB/WE}}$ | $\text{DSF}$ | $\overline{\text{SE}}$ | $\text{DSF}$            | $\overline{\text{RAS}}$ | $\overline{\text{CAS}}$ | $\overline{\text{RAS}}$ | $\overline{\text{CAS}}$ | $\overline{\text{CAS}}$ | $\overline{\text{WE}}$ |            | WM1      | Color |
| $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ Refresh | 0                       | *                         | *                         | *            | *                      | -                       | *                       | -                       | *                       | -                       | -                       | -                      | -          | -        | -     |
| Write Transfer                                                 | 1                       | 0                         | 0                         | 0            | 0                      | *                       | Row                     | TAP                     | *                       | *                       | *                       | -                      | -          | -        | -     |
| Pseudo Write Transfer                                          | 1                       | 0                         | 0                         | 0            | 1                      | *                       | Row                     | TAP                     | *                       | *                       | *                       | -                      | -          | -        | -     |
| Write Transfer                                                 | 1                       | 0                         | 0                         | 1            | *                      | *                       | Row                     | TAP                     | *                       | *                       | *                       | -                      | -          | -        | -     |
| Read Transfer                                                  | 1                       | 0                         | 1                         | 0            | *                      | *                       | Row                     | TAP                     | *                       | *                       | *                       | -                      | -          | -        | -     |
| Split Read Transfer                                            | 1                       | 0                         | 1                         | 1            | *                      | *                       | Row                     | TAP                     | *                       | *                       | *                       | -                      | -          | -        | -     |
| Write per Bit 1                                                | 1                       | 1                         | 0                         | 0            | *                      | 0                       | Row                     | Column                  | WM1                     | -                       | DIN                     | WM1                    | Load use   | -        | -     |
| Block Write (Mask 1)                                           | 1                       | 1                         | 0                         | 0            | *                      | 1                       | Row                     | Column A2C-8C           | WM1                     | Column Select           | -                       | WM1                    | Load use   | use      | -     |
| Write per Bit 2                                                | 1                       | 1                         | 0                         | 1            | *                      | 0                       | Row                     | Column                  | *                       | -                       | DIN                     | WM1                    | use        | -        | -     |
| Block Write (Mask 2)                                           | 1                       | 1                         | 0                         | 1            | *                      | 1                       | Row                     | Column A2C-8C           | *                       | Column Select           | -                       | WM1                    | use        | use      | -     |
| Read Write                                                     | 1                       | 1                         | 1                         | 0            | *                      | 0                       | Row                     | Column                  | *                       | -                       | DIN                     | -                      | -          | -        | -     |
| Block Write                                                    | 1                       | 1                         | 1                         | 0            | *                      | 1                       | Row                     | Column A2C-8C           | *                       | Column Select           | -                       | -                      | -          | -        | use   |
| Load Mask                                                      | 1                       | 1                         | 1                         | 1            | *                      | 0                       | Row                     | *                       | *                       | -                       | WM1                     | -                      | Load       | -        | -     |
| Load Color                                                     | 1                       | 1                         | 1                         | 1            | *                      | 1                       | Row                     | *                       | *                       | -                       | Color                   | -                      | -          | Load     | -     |

\* : "0" or "1" , TAP : SAM start address , - : not used

If the special function control input (DSF) is in the "low" state at the falling edges of  $\overline{RAS}$  and  $\overline{CAS}$ , only the conventional multiport DRAM operating features can be invoked:  $\overline{CAS}$ -before- $\overline{RAS}$  refresh, write transfer, pseudo-write transfer, read transfer and read write modes. If the DSF input is "high" at the falling edge of  $\overline{RAS}$ , special features such as split read transfer, load mask, load color register, write per bit 2 and block write (Mask 2), can be invoked. If the DSF input is "low" at the falling edge of  $\overline{RAS}$  and "high" at the falling edge of  $\overline{CAS}$ , the block write (No Mask, Mask 1) feature can be invoked.

## RAM PORT OPERATION

### FAST PAGE MODE CYCLE

Fast page mode allows data to be transferred into or out of multiple column locations of the same row by performing multiple  $\overline{CAS}$  cycle during a single active  $\overline{RAS}$  cycle. During a fast page cycle, the  $\overline{RAS}$  signal may be maintained active for a period up to 100  $\mu$ seconds. For the initial fast page mode access, the output data is valid after the specified access times from  $\overline{RAS}$ ,  $\overline{CAS}$ , column address and  $\overline{DT}/\overline{OE}$ . For all subsequent fast page mode read operations, the output data is valid after the specified access times from  $\overline{CAS}$ , column address and  $\overline{DT}/\overline{OE}$ . When the write-per-bit function is enabled, the mask data latched at the falling edge of  $\overline{RAS}$  is maintained throughout the fast page mode write or read-modify-write cycle.

### $\overline{RAS}$ -ONLY REFRESH

The data in the DRAM requires periodic refreshing to prevent data loss. Refreshing is accomplished by performing a memory cycle at each of the 512 rows in the DRAM array within the specified 8ms refresh period. Although any normal memory cycle will perform the refresh operation, this function is most easily accomplished with " $\overline{RAS}$ -Only" cycle.

### $\overline{CAS}$ -BEFORE- $\overline{RAS}$ REFRESH

The TC524259BJ/BZ also offers an internal-refresh function. When  $\overline{CAS}$  is held "low" for a specified period ( $t_{CSR}$ ) before  $\overline{RAS}$  goes "low", an internal refresh address counter and on-chip refresh control clock generators are enabled and an internal refresh operation takes place. When the refresh operation is completed, the internal refresh address counter is automatically incremented in preparation for the next  $\overline{CAS}$ -before- $\overline{RAS}$  cycle. For successive  $\overline{CAS}$ -before- $\overline{RAS}$  refresh cycle,  $\overline{CAS}$  can remain "low" while cycling  $\overline{RAS}$ .

### HIDDEN REFRESH

A hidden refresh is a  $\overline{CAS}$ -before- $\overline{RAS}$  refresh performed by holding  $\overline{CAS}$  "low" from a previous read cycle. This allows for the output data from the previous memory cycle to remain valid while performing a refresh. The internal refresh address counter provides the address and the refresh is accomplished by cycling  $\overline{RAS}$  after the specified  $\overline{RAS}$ -precharge period (Refer to Figure 1).

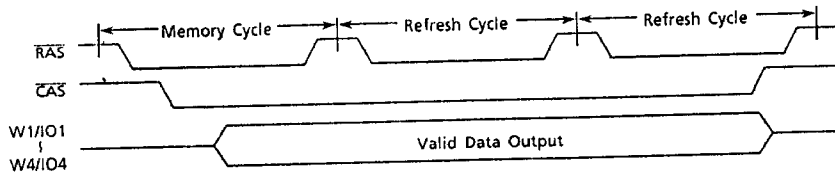


Figure 1. Hidden Refresh Cycle

### WRITE-PER-BIT FUNCTION

The write-per-bit function selectively controls the internal write-enable circuits of the RAM port. Two types of write-per-bit may be utilized—"New Mask Mode" or "Old Mask Mode". The state of the signals required to select the modes of write-per-bit are shown in table 3.

The write-per-bit 1 (New Mask Mode) function is enabled when  $\overline{WB}/\overline{WE}$  and DSF are held "low" at the falling edge of  $\overline{RAS}$  in a random write operation. Also, at the falling edge of  $\overline{RAS}$ , the mask data on the  $W_i/IO_i$  pins are latched into a write mask register (WM1). New write mask data must be presented at the  $W_i/IO_i$  pins at every falling edge of  $\overline{RAS}$ . A "0" on any of the  $W_i/IO_i$  pins will disable the corresponding write circuits and new data will not be written into the RAM. A "1" on any of the  $W_i/IO_i$  pins will enable the corresponding write circuits and new data will be written into the RAM.

The write-per-bit 2 (Old Mask Mode) function is enabled when  $\overline{WB}/\overline{WE}$  is "low" and DSF is "high" at the falling edge of  $\overline{RAS}$  in a random write operation. This function does not use the data present on the  $W_i/IO_i$  pins at the falling edge of  $\overline{RAS}$  as write mask data. Therefore, data on the  $W_i/IO_i$  pins at the falling edge of  $\overline{RAS}$  is a don't care ("H" or "L"). The write mask data which is utilized by this function resides in the write mask register (WM1). The mask data is placed into the "WM1" write mask register by using either the "Load Mask Register Cycle", "Write-per-bit 1 (New Mask Mode) Function", or "Block Write 1 (New Mask Mode) Function"

Table 3. Write-per-bit function truth table

| At the falling edge of $\overline{RAS}$ ( $\overline{RAS} \searrow$ ) |                               |                               |     |      | $\overline{CAS} \searrow$ | Function                        |
|-----------------------------------------------------------------------|-------------------------------|-------------------------------|-----|------|---------------------------|---------------------------------|
| $\overline{CAS}$                                                      | $\overline{DT}/\overline{OE}$ | $\overline{WB}/\overline{WE}$ | DSF | W/IO | DSF                       |                                 |
| H                                                                     | H                             | H                             | L   | *    | L                         | Normal Write                    |
| H                                                                     | H                             | L                             | L   | WM1  | L                         | Write-per-bit 1 (New Mask Mode) |
| H                                                                     | H                             | L                             | H   | *    | L                         | Write-per-bit 2 (Old Mask Mode) |

\* : don't care (H or L)

An example of the write-per-bit function using a display application is shown in Figures 2 and 3.

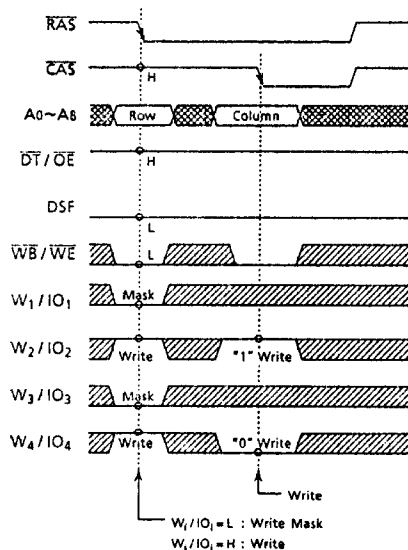


Figure 2. Write-per-bit 1 timing cycle

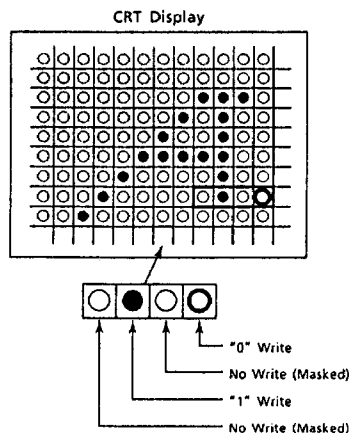


Figure 3. Corresponding bit-map

## LOAD COLOR REGISTER

The TC524259BJ/BZ is provided with an on-chip 4-bits register (color register) which is used in the block write function. Each bit of the color register corresponds to one of the DRAM I/O blocks. The load color register cycle is initiated by holding  $\overline{\text{CAS}}$ ,  $\overline{\text{DT/OE}}$ ,  $\overline{\text{WB/WE}}$  and DSF "high" at the falling edge of  $\overline{\text{RAS}}$  and by holding DSF "low" at the falling edge of  $\overline{\text{CAS}}$ . The data presented on the  $W_i/\text{IO}_i$  lines are subsequently latched into the color register at the falling edge of  $\overline{\text{CAS}}$  or  $\overline{\text{WB/WE}}$ , whichever occurs later. During the load color register cycle, a valid row address ( $A_0$  thru  $A_8$ ) is not required. However, the memory cells of the row address which is latched at the falling edge of  $\overline{\text{RAS}}$  is refreshed.

LOAD MASK REGISTER

The TC524259BJ/BZ has an on-chip 4 bit register (WM1 register) which provides the I/O mask data during the write-per-bit (New and Old Mask Mode) and Block Write (New and Old Mask Mode) functions. Each bit of the mask register corresponds to one of the DRAM I/O blocks.

The mask data must be specified in the WM1 register by using the load mask register cycle prior to the execution of "Write-Per-Bit 2" and "Block Write 2" old mask mode functions. The load mask register cycle is initiated by holding  $\overline{\text{CAS}}$ ,  $\overline{\text{DT}}/\overline{\text{OE}}$ ,  $\overline{\text{WB}}/\overline{\text{WE}}$  and DSF "high" at the falling edge of  $\overline{\text{RAS}}$  and by DSF "high" at the falling edge of  $\overline{\text{CAS}}$ . The data presented on the  $W_i/\text{IO}_i$  lines are subsequently latched into the mask register at the falling edge of either  $\overline{\text{CAS}}$  or  $\overline{\text{WB}}/\overline{\text{WE}}$ , whichever occurs later. The mask data which is latched into the WM1 register will also be updated by the write-per-bit 1 (New Mask Mode) or Block Write 1 (New Mask Mode) functions. During the load mask register cycle, a valid row address ( $A_0$  thru  $A_9$ ) is not required. However, the memory cells of the row address which is latched at the falling edge of  $\overline{\text{RAS}}$  is refreshed.

BLOCK WRITE

Block write is a special RAM port write operation which, in a single  $\overline{\text{RAS}}$  cycle, writes the data in the color register into 4 consecutive column address locations starting from a selected column in a selected row. Three modes of block write operation may be selected-No Mask Mode, New Mask Mode, Old Mask Mode. Column mask capability is applicable on all three modes. The seven most significant column addresses ( $A_{2C}\sim A_{8C}$ ) are latched at the falling edge of  $\overline{\text{CAS}}$  to designate the starting column address and the two least significant column addresses ( $A_{0C}\sim A_{1C}$ ) are "don't care". The column mask data is also provided on the  $W_i/\text{IO}_i$  pins at the falling edge of  $\overline{\text{CAS}}$ . This column mask data will enable/disable the write operation on any of the 4 consecutive column address locations.

A block write cycle is selected by holding  $\overline{\text{CAS}}$ , and  $\overline{\text{DT}}/\overline{\text{OE}}$  "high" at the falling edge of  $\overline{\text{RAS}}$  and DSF "high" at the falling edge of  $\overline{\text{CAS}}$ . The state of the  $\overline{\text{WB}}/\overline{\text{WE}}$  and DSF inputs at the falling edge of  $\overline{\text{RAS}}$  will select one of the three modes of block write as shown in the following table 4.

When the DSF input at the falling edge of  $\overline{\text{RAS}}$  is "low", the state of  $\overline{\text{WB}}/\overline{\text{WE}}$  selects either "No Mask Mode" or "New Mask Mode". If  $\overline{\text{WB}}/\overline{\text{WE}}$  is "high" at the falling edge of  $\overline{\text{RAS}}$ , the block write (No Mask Mode) is selected. If  $\overline{\text{WB}}/\overline{\text{WE}}$  is "low" at the falling edge of  $\overline{\text{RAS}}$ , the block write 1 (New Mask Mode) is selected and the mask data on the  $W_i/\text{IO}_i$  pins are latched and used like the write-per-bit 1 (New Mask Mode) function.

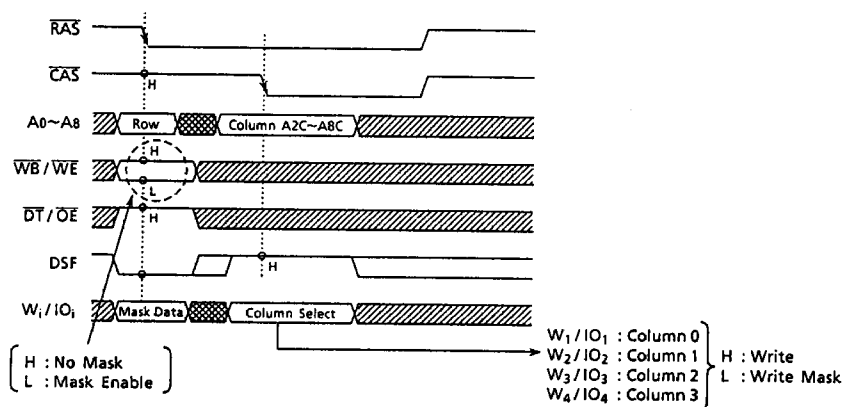
If DSF is "high" and  $\overline{\text{WB}}/\overline{\text{WE}}$  is "low" at the falling edge of  $\overline{\text{RAS}}$ , then the block write 2 (Old Mask Mode) is selected and the mask data stored in the "WM1" register is used. The I/O masking for this function is used in the same manner as the write-per-bit 2 (Old Mask Mode)..

Table 4. Block Write function truth table

| At the falling edge of $\overline{RAS}$ ( $\overline{RAS} \downarrow$ ) |                               |                               |     |            | $\overline{CAS} \downarrow$ |             | Function                             |
|-------------------------------------------------------------------------|-------------------------------|-------------------------------|-----|------------|-----------------------------|-------------|--------------------------------------|
| $\overline{CAS}$                                                        | $\overline{DT}/\overline{OE}$ | $\overline{WB}/\overline{WE}$ | DSF | $W_1/IO_1$ | DSF                         | $W_1/IO_1$  |                                      |
| H                                                                       | H                             | H                             | L   | *          | H                           | Column Mask | Block Write (No Mask Mode)           |
| H                                                                       | H                             | L                             | L   | WM1        | H                           | Column Mask | Block Write (Mask 1) (New Mask Mode) |
| H                                                                       | H                             | L                             | H   | *          | H                           | Column Mask | Block Write (Mask 2) (Old Mask Mode) |

\* : don't care (H or L)

An example using the block write 1 (New Mask Mode) function with a data mask on  $W_1/IO_1$ ,  $W_4/IO_4$  and column 2 is shown in Figure 5. Also, an example using a window clear and fill application is shown in Figure 6.



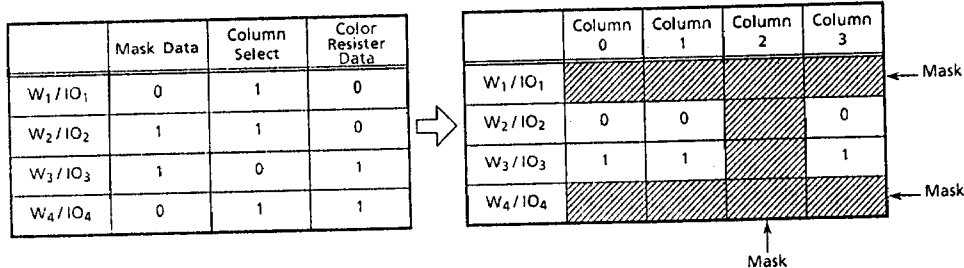


Figure 5. Example of Block Write Operation

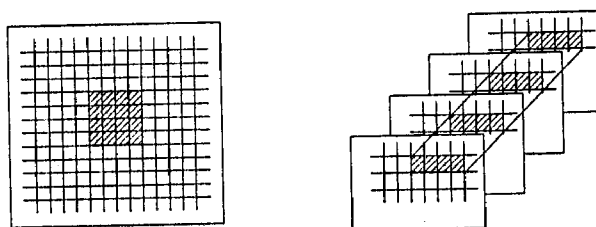


Figure 6. Examples of Block Write Application

## FAST PAGE MODE BLOCK WRITE CYCLE

Fast page mode block write can be used to perform high speed clear and fill operations. The cycle is initiated by holding the DSF signal "low" at the falling edge of  $\overline{RAS}$  and a fast page mode block write is performed during each subsequent  $\overline{CAS}$  cycle with DSF held "high" at the falling edge of  $\overline{CAS}$ .

If the DSF signal is "low" at the falling edge of  $\overline{CAS}$ , a normal fast page mode read/write operation will occur. Therefore a combination of block write and read/write operations can be performed during a fast page mode block write cycle. Refer to the example shown in Figure 10.

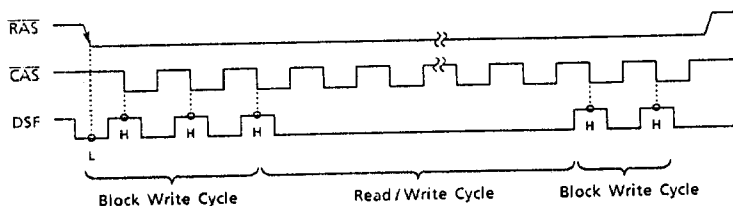


Figure 7. Fast Page Mode Block Write Cycle

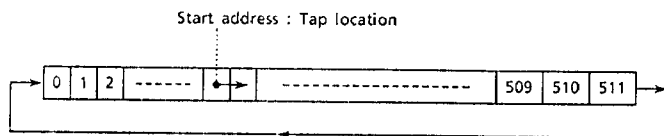
## SAM PORT OPERATION

The TC524259BJ/BZ is provided with a 512 words by 4 bits serial access memory (SAM) which can be operated in the single register mode or the split register mode.

### SINGLE REGISTER MODE

When operating in the single register mode, high speed serial read or write operations can be performed through the SAM port independent of the RAM port operations, except during read/write/pseudo-write transfer cycles. The preceding transfer operation determines the direction of data flow through the SAM port. If the preceding transfer operation is a read transfer, the SAM port is in the output mode. If the preceding transfer operation is a write or pseudo write transfer, the SAM port is in the input mode. The pseudo write transfer operation only switches the SAM port from output mode to input mode; Data is not transferred from SAM to RAM.

Serial data can be read out of the SAM port after a read transfer (RAM→SAM) has been performed. The data is shifted out of the SAM port starting at any of the 512 bits locations. The TAP location corresponds to the column address selected at the falling edge of  $\overline{CAS}$  during the read transfer cycle. The SAM registers are configured as circular data registers. The data is shifted out sequentially starting from the selected tap location to the most significant bit and then wraps around to the least significant bit, as illustrated below.



Subsequent real-time read transfer may be performed on-the-fly as many times as desired, within the refresh constraints of the DRAM array. Simultaneous serial read operation can be performed with some timing restrictions. A pseudo write transfer cycle is performed to change the SAM port from output mode to input mode in order to write data into the serial registers through the SAM port. A write transfer cycle must be used subsequently to load the SAM data into the RAM row selected by the row address at the falling edge of  $\overline{RAS}$ . The starting location in the SAM registers for the next serial write is selected by the column address at the falling edge of  $\overline{CAS}$ . The truth table for single register mode SAM operation is shown in Table 5.

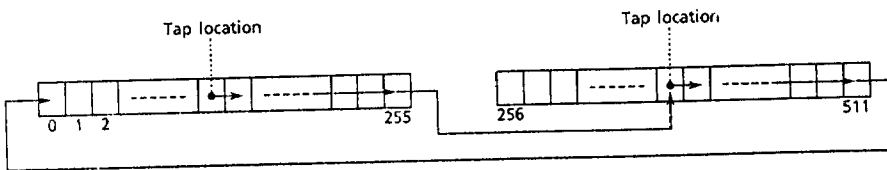


Table 5. Truth Table for SAM Port Operation

| SAM PORT OPERATION | $\overline{DT}/\overline{OE}$ at the falling edge of $\overline{RAS}$ | SC | $\overline{SE}$ | FUNCTION             | Preceded by a         |
|--------------------|-----------------------------------------------------------------------|----|-----------------|----------------------|-----------------------|
| Serial Output Mode | H                                                                     |    | L               | Enable Serial Read   | Read Transfer         |
|                    |                                                                       |    | H               | Disable Serial Read  |                       |
| Serial Input Mode  |                                                                       |    | L               | Enable Serial Write  | Write Transfer        |
|                    |                                                                       |    | H               | Disable Serial Write |                       |
| Serial Input Mode  |                                                                       |    | L               | Enable Serial Write  | Pseudo Write Transfer |
|                    |                                                                       |    | H               | Disable Serial Write |                       |

## SPLIT REGISTER MODE

In split register mode, data can be shifted out of one half of the SAM while a split read transfer is being performed on the other half of the SAM. A normal (Non-split) read transfer operation must precede any split read transfer operation. The non-split read transfer will set the SAM port into output mode. The split read transfers will not change the SAM port mode set by preceding normal transfer operation. RAM port operation may be performed independently except during split transfers. In the split register mode, serial data can be shifted out of one of the split SAM registers starting from any at the 256 tap locations, excluding the last address of each split SAM, data is shifted out sequentially starting from the selected tap location to the most significant bit (255 or 511) of the first split SAM and then the SAM pointer moves to the tap location selected for the second split SAM to shift data out sequentially starting from this tap location to the most significant bit (511 or 255) and finally wraps around to the least significant bit, as illustrated in the example below.



## REFRESH

The SAM data registers are static flip-flop, therefore a refresh is not required.

## DATA TRANSFER OPERATION

The TC524259BJ/BZ features two types of internal data transfer capability between RAM and the SAM, as shown in Figure 8. During a normal (Non-split) transfer, 512 words by 4 bits of data can be loaded from RAM to SAM (Read Transfer) or from SAM to RAM (Write Transfer). During a split read transfer, 256 words by 4 bits of data can be loaded from the lower/upper half of the RAM into the lower/upper half of the SAM (Split Read Transfer). The normal transfer and split transfer modes are controlled by the DSF special function input signal.

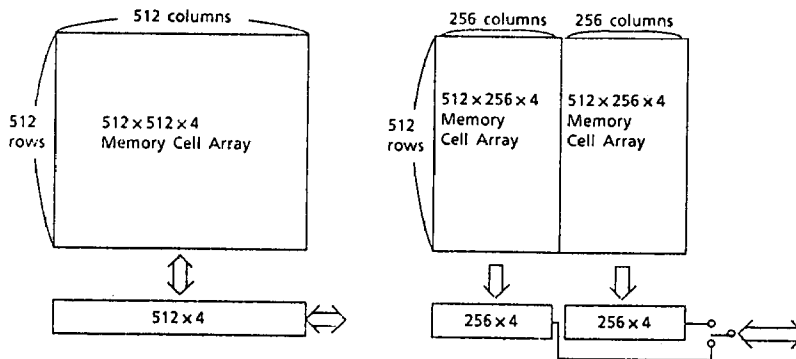


Figure 8. (a) Normal (Non-split) Transfer

(b) Split Read Transfer

As shown in Table 6, the TC524259BJ/BZ supports four types of transfer operations: Read transfer, Split read transfer, Write transfer, and Pseudo write transfer. Data transfer operations between RAM and SAM are invoked by holding the  $\overline{DT}/\overline{OE}$  signal "low" at the falling edge of  $\overline{RAS}$ . The type of data transfer operation is determined by the state of  $\overline{CAS}$ ,  $\overline{WB}/\overline{WE}$ ,  $\overline{SE}$  and DSF latched at the falling edge of  $\overline{RAS}$ . During normal (Non-split) data transfer operations, the SAM port is switched from input to output mode (Read transfer) or output to input mode (Write transfer/Pseudo write transfer) whereas it remains unchanged during split read transfer operations. During a data transfer cycle, the row address  $A_0 \sim A_8$  select one of the 512 rows of the memory array to or from which data will be transferred and the column address  $A_0 \sim A_8$  select one of the tap locations in the serial register. The selected tap location is the start position in the SAM port from which the first serial data will be read out during the subsequent serial read cycle or the start position in the SAM port into which the first serial data will be written during the subsequent serial write cycle. During split read transfer cycles, the most significant column address ( $A_8C$ ) is controlled internally to determine which half of the serial register will be reloaded from the RAM array.

Table 5. Transfer Modes

| at the falling edge of $\overline{RAS}$ |                               |                               |                 |     | Transfer Mode         | Transfer Direction    | Transfer Bit   | SAM Port Mode              |
|-----------------------------------------|-------------------------------|-------------------------------|-----------------|-----|-----------------------|-----------------------|----------------|----------------------------|
| $\overline{CAS}$                        | $\overline{DT}/\overline{OE}$ | $\overline{WB}/\overline{WE}$ | $\overline{SE}$ | DSF |                       |                       |                |                            |
| H                                       | L                             | H                             | *               | L   | Read Transfer         | RAM $\rightarrow$ SAM | 512 $\times$ 4 | Input $\rightarrow$ Output |
| H                                       | L                             | L                             | L               | L   | Write Transfer        | SAM $\rightarrow$ RAM | 512 $\times$ 4 | Output $\rightarrow$ Input |
| H                                       | L                             | L                             | H               | L   | Pseudo Write Transfer | -                     | -              | Output $\rightarrow$ Input |
| H                                       | L                             | L                             | *               | H   | Write Transfer        | SAM $\rightarrow$ RAM | 256 $\times$ 4 | Output $\rightarrow$ Input |
| H                                       | L                             | H                             | *               | H   | Split Read Transfer   | RAM $\rightarrow$ SAM | 256 $\times$ 4 | Not changed                |

\* : "H" or "L"

## READ TRANSFER CYCLE

A read transfer consists of loading a selected row of data from the RAM array into the SAM register. A read transfer is invoked by holding  $\overline{CAS}$  "high",  $\overline{DT}/\overline{OE}$  "low",  $\overline{WB}/\overline{WE}$  "high" and DSF "low" at the falling edge of  $\overline{RAS}$ . The row address selected at the falling edge of  $\overline{RAS}$  determines the RAM row to be transferred into the SAM. The transfer cycle is completed at the rising edge of  $\overline{DT}/\overline{OE}$ . When the transfer is completed, the SAM port is set into the output mode. In a read/real time read transfer cycle, the transfer of a new row of data is completed at the rising edge of  $\overline{DT}/\overline{OE}$  and this data becomes valid on the SIO lines after the specified access time  $t_{SCA}$  from the rising edge of the subsequent serial clock (SC) cycle. The start address of the serial pointer of the SAM is determined by the column address selected at the falling edge of  $\overline{CAS}$ .

Figure 9 shows the operation block diagram for read transfer operation.

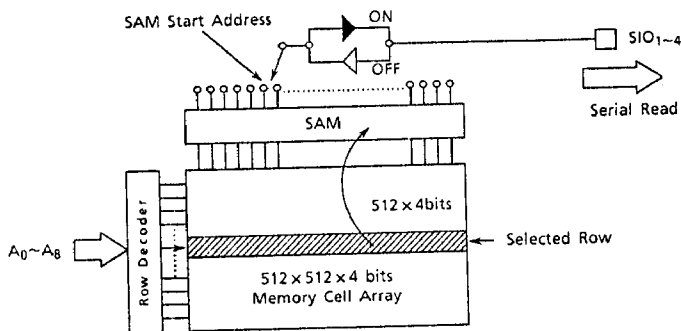


Figure 9. Block Diagram for Read Transfer Operation

In a read transfer cycle (which is preceded by a write transfer cycle), the SC clock must be held at a constant  $V_{IL}$  or  $V_{IH}$ , after the SC high time has been satisfied. A rising edge of the SC clock must not occur until after the specified delay  $t_{RSD}$  from the rising edge of  $\overline{DT}/\overline{OE}$ , as shown in Figure 10.

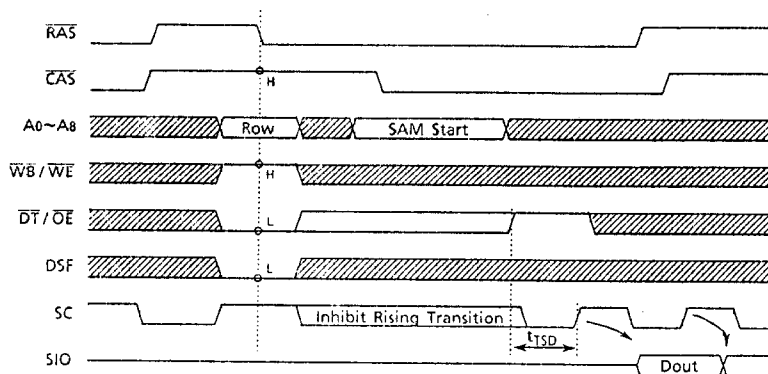


Figure 10. Read Transfer Timing

In a real time read transfer cycle (which is preceded by another read transfer cycle), the previous row data appears on the SIO lines until the  $\overline{DT}/\overline{OE}$  signal goes "high" and the serial access time  $t_{SCA}$  for the following serial clock is satisfied. This feature allows for the first bit of the new row of data to appear on the serial output as soon as the last bit of the previous row has been strobed without any timing loss. To make this continuous data flow possible, the rising edge of  $\overline{DT}/\overline{OE}$  must be synchronized with  $\overline{RAS}$ ,  $\overline{CAS}$  and the subsequent rising edge of SC ( $t_{RTH}$ ,  $t_{CTH}$ , and  $t_{TSL}/t_{TSD}$  must be satisfied), as shown in Figure 11.

The timing restriction  $t_{TSL}/t_{TSD}$  are 5ns min/15ns min. The split read transfer mode eliminates these timing restrictions.

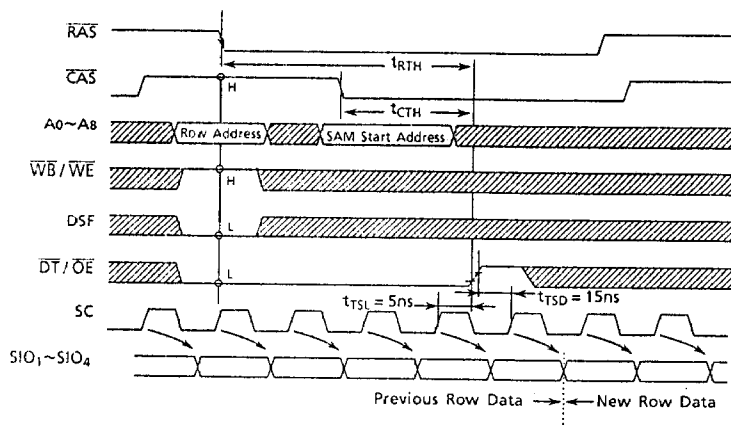
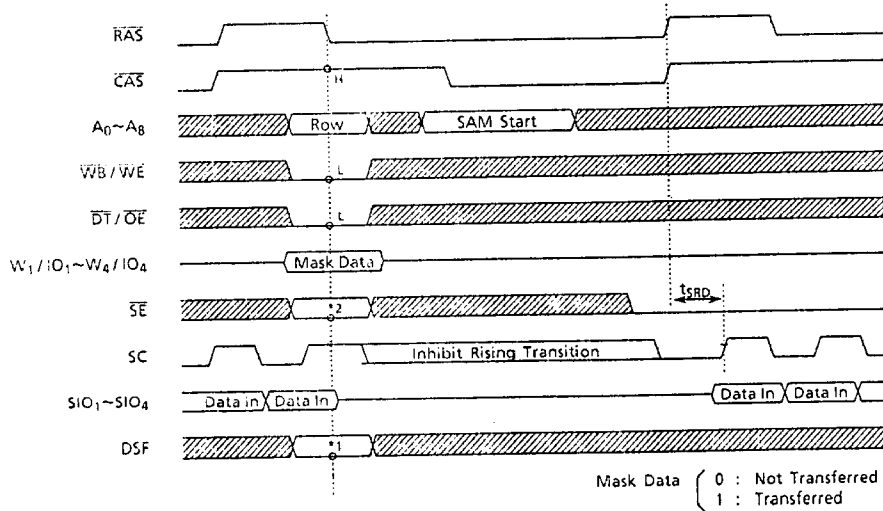


Figure 11. Real Time Read Transfer

# WRITE TRANSFER CYCLE

A write transfer cycle transfers the contents of the SAM register into a selected row of the RAM array. If the SAM data to be transferred must first be loaded through the SAM port, a pseudo write transfer operation must precede the write transfer cycles. However, if the SAM data to be transferred into the RAM was previously loaded into the SAM via a read transfer, the SAM to RAM transfer can be executed simply by performing a write transfer cycle. A write transfer is invoked by holding  $\overline{\text{CAS}}$  "high",  $\overline{\text{DT}}/\overline{\text{OE}}$  "low",  $\overline{\text{WB}}/\overline{\text{WE}}$  "low",  $\overline{\text{SE}}$  "low" and DSF "low" at the falling edge of  $\overline{\text{RAS}}$ . Also if DSF is "high" under the condition of a "high"  $\overline{\text{CAS}}$ , "low"  $\overline{\text{DT}}/\overline{\text{OE}}$  and "low",  $\overline{\text{WB}}/\overline{\text{WE}}$  at the falling edge of  $\overline{\text{RAS}}$ , a write transfer is invoked independent of the state of  $\overline{\text{SE}}$ .



| *1 DSF | *2 $\overline{\text{SE}}$ | Operation      |
|--------|---------------------------|----------------|
| L      | L                         | Write Transfer |
| H      | L or H                    | Write Transfer |

Figure 12. Write Transfer Timing

The row address selected at the falling edge of  $\overline{\text{RAS}}$  determines the RAM row address into which the data will be transferred. The column address selected at the falling edge of  $\overline{\text{CAS}}$  determines the start address of the serial pointer of the SAM. After the write transfer is completed, the SIO lines are set in the input mode so that serial data synchronized with the SC clock can be loaded.

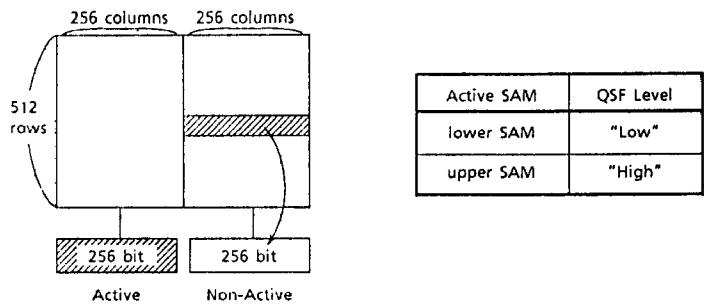


Figure 14. Split Register Mode

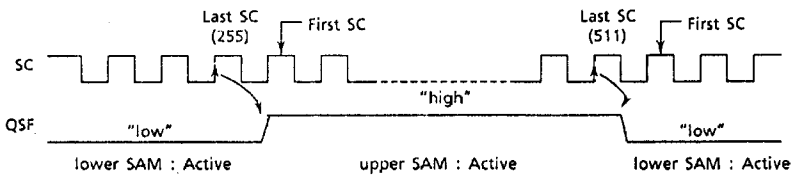


Figure 15. QSF Output State During Split Register Mode

SPLIT READ TRANSFER CYCLE

A split read transfer consists of loading 256 words by 4 bits of data from a selected row of the split RAM array into the corresponding non-active split SAM register.

Serial data can be shifted out of the other half of the split SAM register simultaneously. The block diagram and timing diagram for split read transfer mode are shown in Figure 16 and 17, respectively. During split read transfer operation, the RAM port input clocks do not have to be synchronized with the serial clock SC, thus eliminating timing restrictions as in the case of on-the-fly read transfers. A split read transfer can be performed after a delay of  $t_{STS}$ , from the change of state of the QSF output, is satisfied.

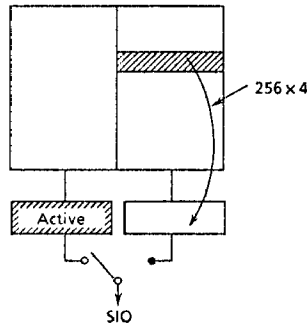


Figure 16. Block Diagram for Split Read Transfer

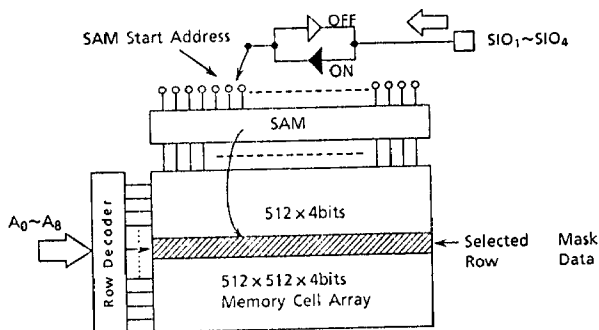


Figure 13. Block Diagram for Write Transfer Operation

When consecutive write transfer operations are performed, new data must not be written into the serial register until the  $\overline{\text{RAS}}$  cycle of the preceding write transfer is completed. Consequently, the SC clock must be held at a constant  $V_{IL}$  or  $V_{IH}$  during the  $\overline{\text{RAS}}$  cycle. A rising edge of the SC clock is only allowed after the specified delay  $t_{SRD}$  from the rising edge of  $\overline{\text{RAS}}$ , at which time a new row of data can be written in the serial register.

#### PSEUDO WRITE TRANSFER CYCLE

A pseudo write transfer cycle must be performed before loading data into the serial register after a read transfer operation has been executed. The only purpose of a pseudo write transfer is to change the SAM port mode from output mode to input mode (A data transfer from SAM to RAM does not occur). After the serial register is loaded with new data, a write transfer cycle must be performed to transfer the data from SAM to RAM. A pseudo write transfer is invoked by holding  $\overline{\text{CAS}}$  "high",  $\overline{\text{DT}}/\overline{\text{OE}}$  "low",  $\overline{\text{WB}}/\overline{\text{WE}}$  "low",  $\overline{\text{SE}}$  "high" and  $\overline{\text{DSF}}$  "low" at the falling edge of  $\overline{\text{RAS}}$ . The timing conditions are the same as the one for the write transfer cycle except for the state of  $\overline{\text{SE}}$  at the falling edge of  $\overline{\text{RAS}}$ .

#### SPLIT READ TRANSFER AND QSF

The TC524259BJ/BZ features a split read transfer capability between the RAM and the SAM. During split read transfer operation, the serial register is split into two halves which can be controlled independently. Split read transfer operations can be performed to one half of the serial register while serial data can be shifted out of the other half of the serial register, as shown in Figure 14. The most significant column address location (A8C) is controlled internally to determine which half of the serial register will be reloaded from the RAM array. QSF is an output in which indicates which half of the serial register is in an active state. QSF changes state when the last SC clock is applied to active split SAM, as shown in Figure 15.

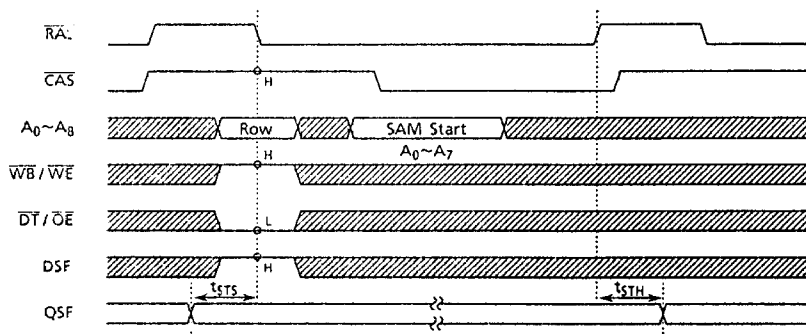


Figure 17. Timing Diagram for Split Read transfer

A normal (Non-split) read transfer operation must precede split read transfer cycles as shown in the example in Figure 18.

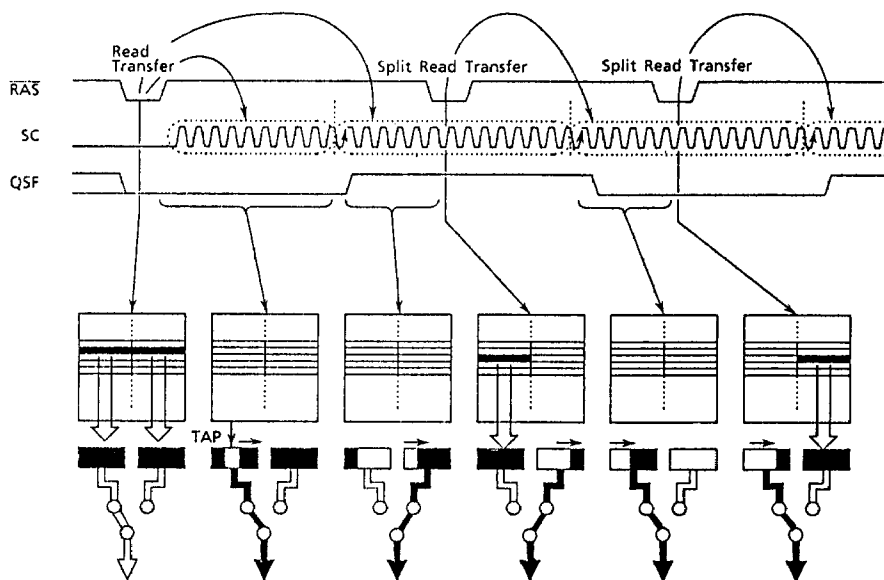


Figure 18. Example of Consecutive Read Transfer Operations



SPLIT-REGISTER OPERATION SEQUENCE (EXAMPLE)

Split read transfers must be preceded by a normal read transfer. Figure 19 illustrates an example of split register operation sequence after device power-up and initialization. After power-up, a minimum of 8  $\overline{\text{RAS}}$  and 8 SC clock cycles must be performed to properly initialize the device. A read transfer is then performed and the column address latched at the falling edge of  $\overline{\text{CAS}}$  sets the SAM tap pointer location which up to that point was in an undefined location. Subsequently, the pointer address is incremented by cycling the serial clock SC from the starting location to the last location in the register (address 511) and wraps around to the tap location set by the split read transfer performed for the lower SAM while the upper SAM is being accessed. The SAM address is incremented as long as SC is clocked. The following split read transfer sets a new tap location in the upper split SAM register address 256 in this example and the pointer is incremented from this location by cycling the SC clock.

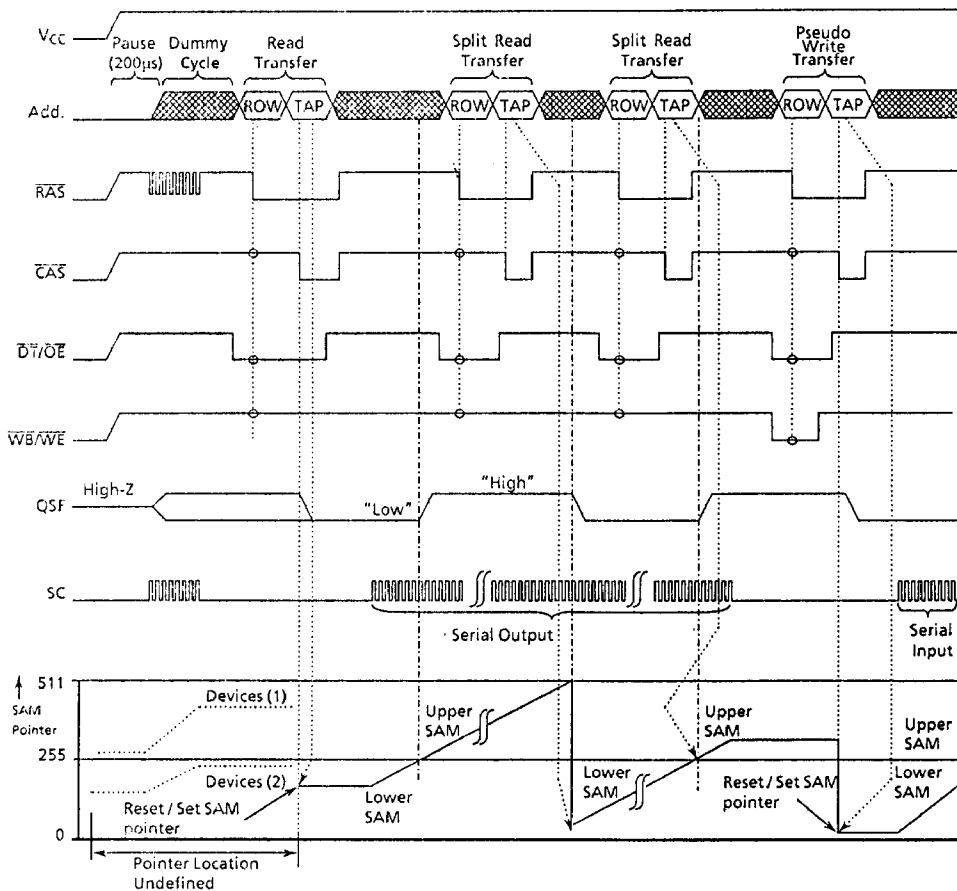
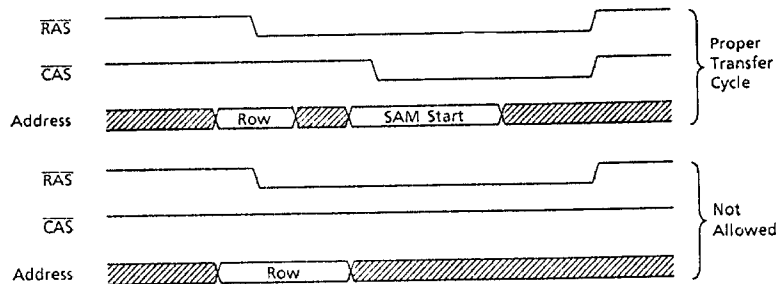


Figure 19. Example of Split SAM Register Operation Sequence

The next operation is a pseudo write transfer which switches the SAM port from output mode to input mode in preparation for either write transfers or split write transfers. The column address latched at the falling edge of  $\overline{\text{CAS}}$  during the pseudo write transfer sets the serial register tap location. Serial data will be written into the SAM starting from this location.

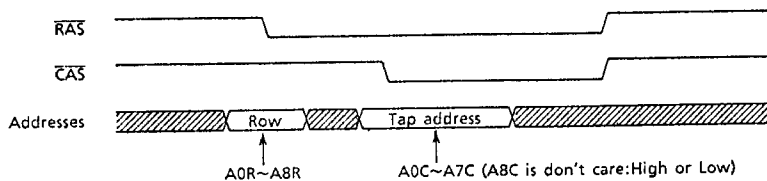
#### TRANSFER OPERATION WITHOUT $\overline{\text{CAS}}$

During all transfer cycles, the  $\overline{\text{CAS}}$  input clock must be cycled, so that the column address are latched at the falling edge of  $\overline{\text{CAS}}$ , to set the SAM tap location. If  $\overline{\text{CAS}}$  was maintained at a constant "high" level during a transfer cycle, the SAM pointer location would be undefined. Therefore a transfer cycle with  $\overline{\text{CAS}}$  held "high" is not allowed (Refer to the illustration below).



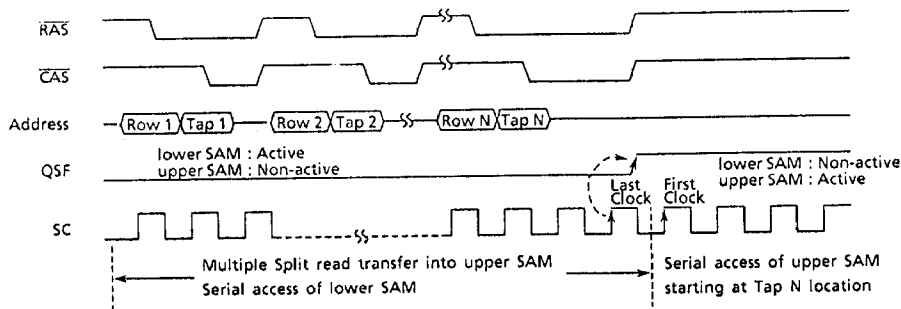
### TAP LOCATION SELECTION IN SPLIT READ TRANSFER OPERATION

- (a) In a split read transfer operation, column addresses A0C through A7C must be latched at the falling edge of  $\overline{\text{CAS}}$  in order to set the tap location in one of the split SAM registers. During a split read transfer, column address A8C is controlled internally and therefore it is ignored internally at the falling edge of  $\overline{\text{CAS}}$ .



During a split transfer, it is not allowed to set the last address location (A0C~A7C=FF), in either the lower SAM or the upper SAM, as the tap location.

- (b) In the case of multiple split read transfers performed into the same split SAM register, the tap location specified during the last split read transfer, before QSF toggles, will prevail. In the example shown below, multiple split read transfers are performed into the upper SAM (Non-active) while the lower SAM (active) is being accessed at the time when QSF toggles, the first SC serial clock will start shifting serial data starting from the Tap N address location.



## SPLIT READ TRANSFER OPERATION ALLOWABLE PERIOD

Figure 26 illustrates the relationship between the serial clock SC and the special function output QSF during split read transfers and highlights the time periods where split read transfer are allowed, relative to SC and QSF.

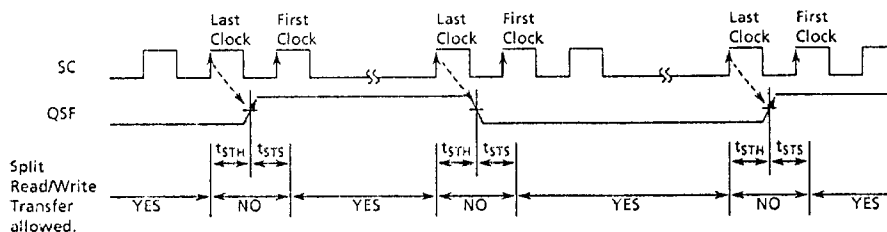
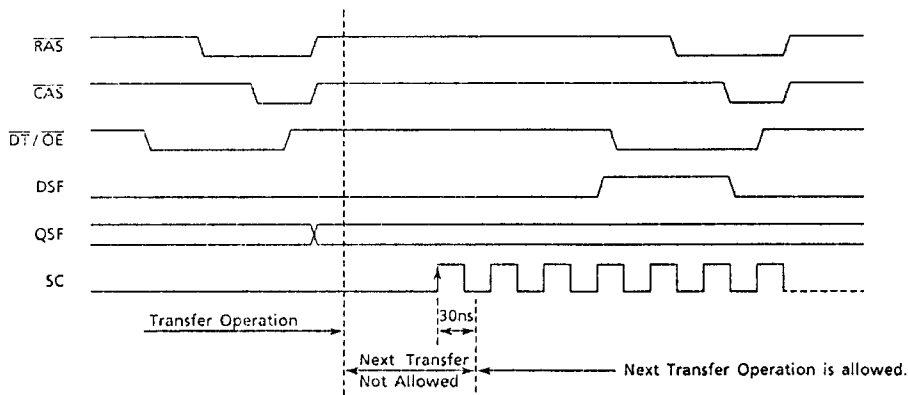


Figure 20. Split Transfer Operation Allowable Periods

As indicated in Figure 20, a split read transfer is not allowed during the period of  $t_{STH} + t_{STS}$ .

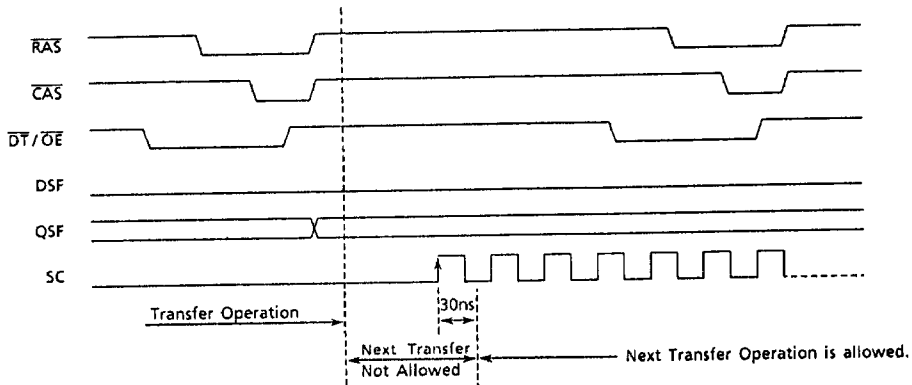
## SPLIT READ TRANSFER CYCLE AFTER NORMAL READ TRANSFER CYCLE

A split read transfer may be performed following a normal read transfer provided that a minimum delay of 30ns from the rising edge of the first clock SC is satisfied (Refer to the illustration shown below).



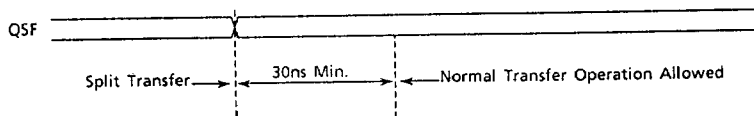
## NORMAL READ TRANSFER CYCLE AFTER NORMAL READ TRANSFER CYCLE

Another read transfer may be performed following the read transfer provided that a minimum delay of 30ns from the rising edge of the first clock SC is satisfied (Refer to the illustration shown below).



## NORMAL TRANSFER AFTER SPLIT READ TRANSFER

A normal transfer (read/write/pseudo write) may be performed following split read transfer operation provided that a 30ns minimum delay is satisfied after the QSF signal toggles.



## POWER-UP

Power must be applied to the  $\overline{\text{RAS}}$  and  $\overline{\text{DT}}/\overline{\text{OE}}$  input signals to pull them "high" before or at the same time as the  $V_{CC}$  supply is turned on. After power-up, a pause of 200  $\mu\text{seconds}$  minimum is required with  $\overline{\text{RAS}}$  and  $\overline{\text{DT}}/\overline{\text{OE}}$  held "high". After the pause, a minimum of 8  $\overline{\text{RAS}}$  and 8 SC dummy cycles must be performed to stabilize the internal circuitry, before valid read, write or transfer operations can begin. During the initialization period, the  $\overline{\text{DT}}/\overline{\text{OE}}$  signal must be held "high". If the internal refresh counter is used, a minimum 8  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  initialization cycles are required instead of 8  $\overline{\text{RAS}}$  cycles.

## INITIAL STATE AFTER POWER-UP

When power is achieved with  $\overline{\text{RAS}}$ ,  $\overline{\text{CAS}}$ ,  $\overline{\text{DT}}/\overline{\text{OE}}$  and  $\overline{\text{WB}}/\overline{\text{WE}}$  held "high", the internal state of the TC524258BJ/BZ is automatically set as follows.

However, the initial state can not be guaranteed for various power-up conditions and input signal levels. Therefore, it is recommended that the initial state be set after the initialization of the device is performed (200  $\mu\text{seconds}$  pause followed by a minimum of 8  $\overline{\text{RAS}}$  cycles and 8 SC cycles) and before valid operations begin.

|                | State after power-up |
|----------------|----------------------|
| SAM port       | Input Mode           |
| QSF            | High-Impedance       |
| Color Register | all "0"              |
| WM1 Register   | Write Enable         |
| TAP pointer    | Invalid              |